

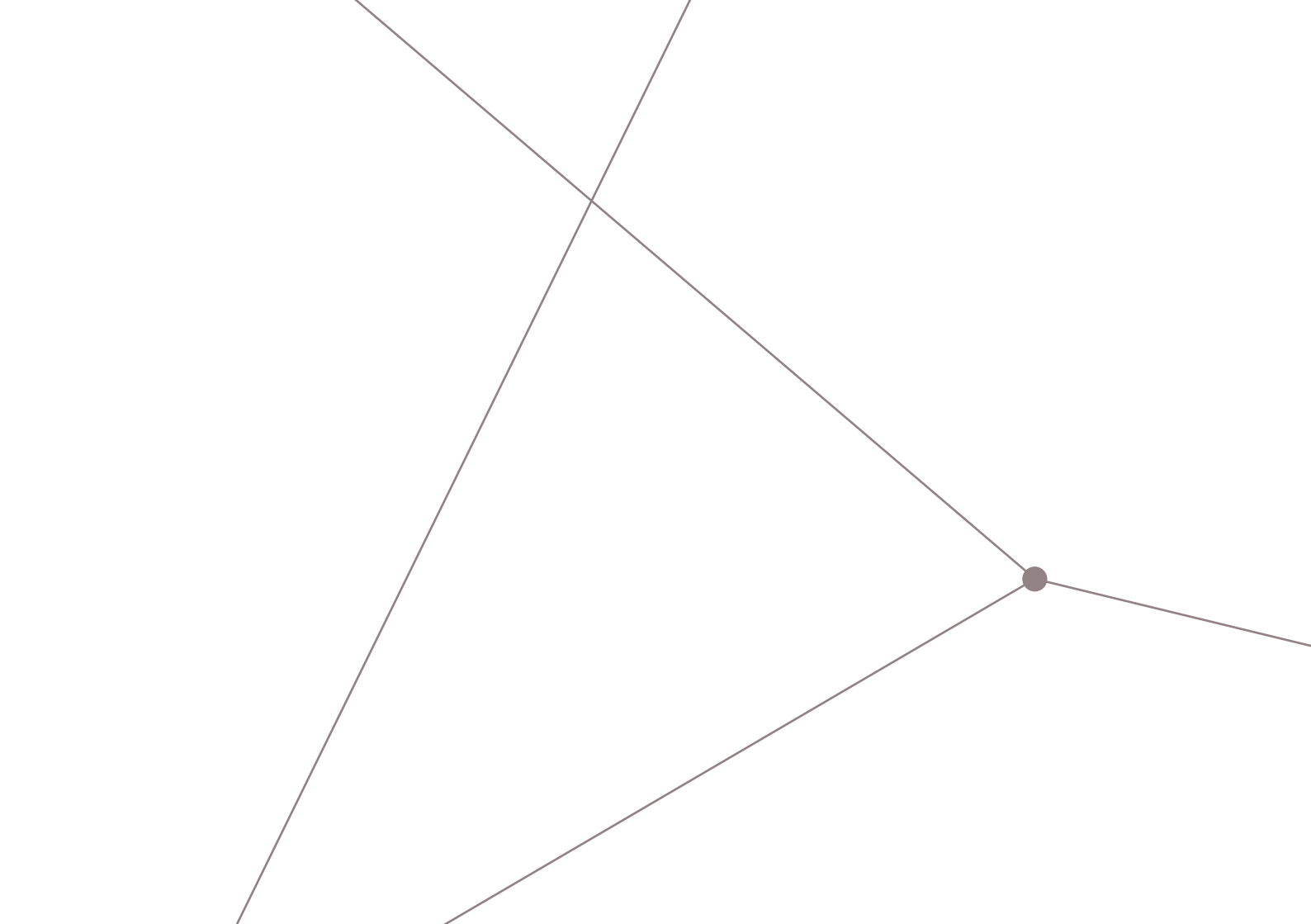


Infineon's Security Solutions Portfolio

Security for the connected world

www.infineon.com/security





Security for the connected world

In an increasingly connected world, securing interaction and communication between people, electronic devices and infrastructures has become a number one priority. As the leading provider of security solutions, Infineon offers tailored, ready-to-use security solutions serving a wide range of applications from smart cards to new, emerging use cases. Infineon is the partner of choice for countless customers across multiple markets thanks to its outstanding security expertise based on almost 30 years of experience, a steady stream of customer-driven technology innovations, in-depth and holistic system competence and the broadest security solution portfolio in the market.

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Technologies



Integrity Guard

The smartest security concept in the industry

Rely on Integrity Guard's highly sophisticated digital security architecture, including a fully encrypted data path and self-checking dual CPU core.



Boosted NFC

NFC security solution for smallest form factors

Deliver payment solutions for connected devices with ultra-low power consumption, small PCB footprints and extraordinary contactless performance.



SOLID FLASH™

Flexible and robust memory built on a comprehensive security concept

Master your security applications quickly with SOLID FLASH™ – a flexible, non-volatile memory technology.



Mega Memory

Unrivalled total memory sizes

Enable your next-generation eGovernment documents such as ePassports and multi-application eID cards based on LDS 2.0.



Coil on Module

Simplified dual-interface card design and manufacturing

Get to market significantly faster than the competition with our award-winning Coil on Module package technology.



VHBR

The fastest contactless performance

Accelerate your applications with support for Very High Bit Rates (VHBR) of up to 6.8 Mbit/s.

Open standard & trademark solutions



CIPURSE™ – Open security standard

- › Is built on proven standards such as ISO/IEC 7816, AES-128 and ISO/IEC 14443-4.
- › Provides a single, consistent set of security, personalization, administration and lifecycle management functions.
- › Includes advanced security mechanisms such as unique cryptographic protocol for inherent protection against differential power analysis (DPA) and differential fault attacks (DFA).
- › Offers three distinct development profiles enabling a complete range of products spanning tickets, cards and mobile phones.

CIPURSE™ is a trademark of the OSPT Alliance

SECORA™

SECORA™ is Infineon's family of one-stop security solutions with integrated operating system (OS) providing a cost-efficient way to fast and agile implementations

SECORA™ Pay offers card issuers, card manufacturers and personalizers a cost-effective route to fast and agile implementation. Based on a solid chip platform with an integrated Java Card operating system, SECORA™ Pay is highly secure and reliable, also delivering the best price-performance ratio.

SECORA™ Connect empowers smart wearables and IoT devices with NFC security capabilities such as payment, transport and access. The solution family consists of various products and complementary services for connected devices and enables ultra-low power consumption for longest battery life-time.

SECORA™ ID is our new ready-to-go Java Card™ solution optimized for all electronic identification (eID) applications. It enables security printers and card manufacturers to accelerate their time-to-market through ready-to-use applets supporting rapid project migration.

OPTIGA™

OPTIGA™ security solutions are designed for easy integration into embedded systems to protect the confidentiality, integrity and authenticity of information and devices. These hardware-based security solutions scale from basic authentication chips to sophisticated implementations.









OPTIGA™ Trust includes turnkey products for smaller platforms as well as programmable solutions, supporting individual needs in the field of embedded authentication and brand protection as well as a host of other security applications.

OPTIGA™ TPM is a standardized security building block used in Trusted Computing and embedded applications. OPTIGA™ TPMs are serving as the basis of a robust implementation of IoT use cases such as secured communication, device authentication, remote management and maintenance, in-field remote feature upgrade, and activation. OPTIGA™ TPM is fully compliant with the Trusted Computing Group (TCG) Standards and ISO/IEC11889:2015.

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Payment






Dual-interface security controllers				
Product name ¹⁾	SLC37PDzxxx  SOLID FLASH™  Coil on Module new	SLC36PDzxxx  SOLID FLASH™  Coil on Module new	SLC32PDzxxx  SOLID FLASH™  Coil on Module	SLC32PMzxxx  SOLID FLASH™  Coil on Module
Product description	Dual-interface security cryptocontroller for multi-application and wearables payment use cases supporting multi-interface	Dual-interface security cryptocontroller for traditional payment use cases	Dual-interface security cryptocontroller for traditional payment use cases	Dual-interface security cryptocontroller for multi-application and wearables payment use cases supporting multi-interface
Interfaces	ISO 7816, ISO 14443 A/B, ISO 18092 passive mode, optimized for small antenna sizes, optional NRG™ (ISO/IEC 14443-3 type A with CRYPTO1)	ISO 7816 / I2C, ISO 14443 A/B, ISO 18092 passive mode, optimized for small antenna sizes, optional NRG™ (ISO/IEC 14443-3 type A with CRYPTO1)	ISO 7816, ISO 14443 A/B, ISO 18092 passive mode, optimized for small antenna sizes, optional NRG™ (ISO/IEC 14443-3 type A with CRYPTO1)	ISO 7816 / I2C, ISO 14443 A/B, ISO 18092 passive mode, optimized for small antenna sizes, optional NRG™ (ISO/IEC 14443-3 type A with CRYPTO1)
NVM	512, 448, 400 kByte	352, 280 kByte	180, 212, 228, 268, 300, 348 kByte	400, 448 kByte
RAM	14 kByte	12 kByte	10 kByte	12 kByte
CPU	32-bit Arm® SecurCore® SC300	32-bit Arm® SecurCore® SC300	16-bit	16-bit
Symmetrical cryptography	AES up to 256-bit, DES, 3DES	AES up to 256-bit, DES, 3DES	AES up to 256-bit, DES, 3DES	AES up to 256-bit, DES, 3DES
Asymmetrical cryptography	ECC up to 521-bit, RSA up to 4096-bit	ECC up to 521-bit, RSA up to 4096-bit	ECC up to 521-bit, RSA up to 4096-bit	ECC up to 521-bit, RSA up to 4096-bit
Ambient temperature	-25°C to +85°C	-25°C to +85°C	-25°C to +85°C	-25°C to +85°C
Delivery forms	Coil on Module, sawn wafer, 6/8 pin dual-interface modules and contactless modules	Coil on Module, sawn wafer, bumped wafer, 6/8 pin dual-interface modules and contactless modules	Coil on Module, sawn wafer, 6/8 pin dual-interface modules and contactless modules	Coil on Module, sawn wafer, bumped wafer, 6/8 pin dual-interface modules and contactless modules
Certifications	Targeted EMVCo, CC EAL6+ high, CUP	Targeted EMVCo, CC EAL6+ high, CUP	CC EAL6+ high, CUP, EMVCo	CC EAL6+ high, EMVCo

¹⁾ Please note that xxx stands for NVM size, z – different interfaces

Payment






	Dual-interface security controllers		Contact-based security controllers	
Product name ¹⁾	SLC52WMzxxx  SOLID FLASH™  Integrity Guard	SLC52BMzxxx  SOLID FLASH™  Integrity Guard 	SLC37PCB240  SOLID FLASH™	SLC32PCAxxx  SOLID FLASH™
Product description	Boosted NFC SE	Biometric system authentication with a biometric sensor in payment smart cards	Contact-based security cryptocontroller	Contact-based security cryptocontroller
Interfaces	ISO 7816 / I2C, ISO 14443 A/B, ISO 18092 passive mode, optimized for small antenna sizes, optional NRG™ (ISO/IEC 14443-3 type A with CRYPTO1)	ISO 7816 / I2C, ISO 14443 A/B, ISO 18092 passive mode, optimized for small antenna sizes, optional NRG™ (ISO/IEC 14443-3 type A with CRYPTO1)	ISO 7816	ISO 7816
NVM	448, 800 kByte	448, 800 kByte	240 kByte	160, 180, 212, 228, 268, 300 kByte
RAM	12 kByte	12, 16 kByte	10 kByte	8 kByte
CPU	16-bit	16-bit	32-bit Arm® SecurCore® SC300	16-bit
Symmetrical cryptography	AES up to 256-bit, DES, 3DES	AES up to 256-bit, DES, 3DES	DES, AES	AES up to 256-bit, DES, 3DES
Asymmetrical cryptography	ECC up to 521-bit, RSA up to 4096-bit	ECC up to 521-bit, RSA up to 4096-bit	–	ECC up to 521-bit, RSA up to 4096-bit
Ambient temperature	-25°C to +85°C	-25°C to +85°C	-25°C to +85°C	-25°C to +85°C
Delivery forms	Sawn wafer, USON-10-2	Sawn wafer	Sawn wafer, 6/8 contact-based modules (MFC6.6, MFC6.8)	Sawn wafer, 6/8 contact-based modules (MFC6.6, MFC6.8)
Certifications	CC EAL6+ high, EMVCo	CC EAL6+ high, EMVCo	EMVCo	CC EAL6+ high, EMVCo

¹⁾ Please note that xxx stands for NVM size, z – different interfaces

	SECORA™ Pay ²⁾		
Product variants	SECORA™ Pay S  SOLID FLASH™  Coil on Module	SECORA™ Pay X  SOLID FLASH™  Coil on Module	SECORA™ Pay W  SOLID FLASH™
Product description	<p>Ready-to-use and optimized chip solution portfolio for standard payment cards for global schemes such as Visa, Mastercard, American Express and Discover.</p>	<p>Flexible platform to address multi-application payment cards and domestic schemes. SECORA™ Pay X is an enablement platform giving customers flexibility to support EMV-based payment schemes and local content in combination with Infineon's ready-to-use reference solutions for Visa, Mastercard, American Express, Discover and CIPURSE™.</p>	<p>Turnkey solution for payment accessories, SECORA™ Pay W is based on innovative and alternative packaging. It is designed to meet market needs for non-connected, passive wearable devices such as rings, wristbands or key fobs that are not powered by a battery.</p>
Operating system	Java Card S GlobalPlatform 2.2.1	Java Card 3.0.4 GlobalPlatform 2.2.1	Java Card 3.0.4 GlobalPlatform 2.2.1
Interfaces	ISO 7816, ISO 14443	ISO 7816, ISO 14443	ISO 14443
Typical application	Standard payment cards	Multi-application payment cards	Smart Accessories

²⁾ For further information on SECORA™ Pay, available products and applets, available configurations, delivery forms, sample availability, support, tools and conditions, please contact your Infineon Technologies sales representative.

Payment





	SECORA™ Connect	
Product Variants	SECORA™ Connect boosted   SOLID FLASH™  Boosted NFC	SECORA™ Connect passive NFC  SOLID FLASH™ 
Product description	SECORA™ Connect Boosted is an all-in-one turnkey NFC solution for connected smart wearables enabling ultra-small physical footprint.	SECORA™ Connect Passive NFC is a security solution for smart wearables enabling battery-less NFC transaction.
Operating system and Applications	Java card 3.0.4, Global platform 2.2.1, Visa Mobile Payment Application, Mastercard M/Chip Mobile application, Proximity Payment System Environment (PPSE), CDCVM, CIPURSE™, and many more upon request	Java card 3.0.4, Global platform 2.2.1, Visa Mobile Payment Application, Mastercard M/Chip Mobile application, Proximity Payment System Environment (PPSE), CDCVM, CIPURSE™, and many more upon request
Interfaces	ISO7816, ISO 14443, I2C	ISO7816, ISO 14443, I2C
Delivery forms	System-in-package with integrated antenna, Multi-Chip-Package	SMD package PG-USON-8-3
Typical applications	Payment, transport ticketing, access control	Payment, transport ticketing, access control
Customer benefits	Fast and easy host integration, longest battery lifetime, one SE fits all, efficient SE management in the field, increased design flexibility	Fast and easy host integration, longest battery lifetime, one SE fits all, efficient SE management in the field, increased design flexibility







Mobile Communication

	SIM & UICCs			
Product name ³⁾	SLC 14MCOxxx	SLC 14MCOxxx	SLE 76CF2564P	SLE 76CFxxx2P
Product description	32-bit SIM card controller	32-bit SIM card controller	16-bit SIM card controller	16-bit SIM card controller
Interfaces	ISO 7816	ISO 7816	ISO 7816	ISO 7816
NVM	256, 288, 312, 340 kByte	384, 420, 480 kByte	256 kByte	296, 320, 344, 360 kByte
RAM	10 kByte	12 kByte	9 kByte	9 kByte
CPU	32-bit	32-bit	16-bit	16-bit
Symmetrical cryptography	-	-	-	-
Asymmetrical cryptography	-	-	-	-
Ambient temperature	-25°C to +85°C	-25°C to +85°C	-25°C to +85°C	-25°C to +85°C
Delivery forms	Sawn wafer	Sawn wafer	Sawn wafer	Sawn wafer
Typical applications	SIM and UICC for mobile communication	SIM and UICC for mobile communication	SIM and UICC for mobile communication	SIM and UICC for mobile communication
Certifications	-	-	-	-

³⁾ Please note that xxx in product names stands for NVM size

SLE 76CF4002P	SLE 76CFxxx0P	SLE 97CNFXxxx0PE  Optimized  SOLID FLASH™	SLE 97CUNFXxxx0PE  SOLID FLASH™	SLC17ECB800B  SOLID FLASH™
16-bit SIM card controller	16-bit SIM card controller	32-bit SWP SIM card security cryptocontroller	32-bit USB and SWP SIM card security cryptocontroller	32-bit security cryptocontroller for SIM and eSIM applications
ISO 7816	ISO 7816	ISO 7816, NRG™ (ISO/IEC 14443-3 type A with CRYPTO1), SWP	ISO 7816, NRG™ (ISO/IEC 14443-3 type A with CRYPTO1), SWP, USB	ISO 7816, GPIO
400 kByte	448, 504 kByte	600, 800 kByte, 1, 1.3, 1.5 MByte	800 kByte, 1 MByte	800 kByte
12 kByte	12 kByte	32 kByte	32 kByte	20 kByte
16-bit	16-bit	32-bit	32-bit	32-bit
–	AES up to 256-bit, DES, 3DES	AES up to 256-bit, DES, 3DES	AES up to 256-bit, DES, 3DES	AES up to 256-bit, DES, 3DES
–	–	ECC up to 521-bit, RSA up to 4096-bit	ECC up to 521-bit, RSA up to 4096-bit	–
-25°C to +85°C	-25°C to +85°C	-25°C to +85°C	-25°C to +85°C	-25°C to +85°C
Sawn wafer	Sawn wafer	SMD, sawn wafer	SMD, sawn wafer	Sawn wafer, MFF2, USON-8-6, USON-6-2, USON-10-2, XFWLB-6-2
SIM and UICC for mobile communication	SIM and UICC for mobile communication	SIM and UICC for mobile communication, SWP UICC for NFC	SIM and UICC for mobile communication	SIM and eSIM for cellular IoT devices
–	–	CC EAL5+ high, EMVCo	CC EAL5+ high, EMVCo	CC EAL5+ high





Mobile Communication

	SIM & UICCs	
Product name ³⁾	SLC16ECB240B  SOLID FLASH™	SLC37MWAxxx   Optimized  SOLID FLASH™
Product description	32-bit security cryptocontroller for SIM and NB-IoT SIM applications	32-bit USB and SWP SIM card security cryptocontroller
Interfaces	ISO 7816	GPIOs, ISO 7816, NRG™ (ISO/IEC 14443-3 type A with CRYPTO1), SPI, SWP, I2C, USB
NVM	240 kByte	1.0, 1.2, 1.5, 2.0 MByte
RAM	12 kByte	48 kByte
CPU	32-bit	32-bit
Symmetrical cryptography	AES up to 256-bit, DES, 3DES	AES up to 256-bit, DES, 3DES
Asymmetrical cryptography	-	ECC up to 521-bit, RSA up to 4096-bit
Ambient temperature	-25°C to +85°C	-25°C to +85°C
Delivery forms	Sawn wafer, USON-8-5, USON-10-2, XFWLB-6-3	Sawn wafer, CSP, SMD
Typical applications	NB-IoT SIM for cellular IoT devices	SIM and UICC for mobile communication
Certifications	CC EAL5+ high	CC EAL6+ high, EMVCo



³⁾ Please note that xxx in product names stands for NVM size







SIM/eSIM/V2X Automotive

	eUICC automotive (V2X)			
Product name ³⁾	SLI 76CF3600P  SOLID FLASH™	SLI 76CF5120P  SOLID FLASH™	SLI 97Cxxx0PE  SOLID FLASH™	SLI 97CSINFxxx0PE  SOLID FLASH™
Product description	Security cryptocontroller, optimized for automotive applications	Security cryptocontroller, optimized for automotive applications	Security cryptocontroller, optimized for automotive applications	Security cryptocontroller, optimized for automotive applications
Interfaces	ISO 7816	ISO 7816	ISO 7816, SWP	ISO 7816, SWP, I2C, SPI
NVM	360 kByte	504 kByte	608 kByte, 800 kByte, 1 MByte	800 kByte, 1 MByte
RAM	8 kByte	12 kByte	32 kByte	32 kByte
CPU	16-bit	16-bit	32-bit	32-bit
Symmetrical cryptography	AES up to 256-bit, DES, 3DES	AES up to 256-bit, DES, 3DES	AES up to 256-bit, DES, 3DES	AES up to 256-bit, DES, 3DES
Asymmetrical cryptography	-	-	ECC up to 521-bit, RSA up to 4096-bit	ECC up to 521-bit, RSA up to 4096-bit
Ambient temperature	-40°C to +105°C	-40°C to +105°C	-40°C to +105°C	-40°C to +105°C
Delivery forms	MFF2 (VQFN-8-4)	MFF2 (VQFN-8-4)	MFF2 (VQFN-8-4)	VQFN-32-13
Typical applications	Automotive SIM	Automotive SIM	Automotive eSIM, eCall	Automotive eSIM, eCall, V2X
Certifications	-	-	CC EAL5+ high	CC EAL5+ high






³⁾ Please note that xxx in product names stands for NVM size

SLI37CMxxx 
 SOLID FLASH™
Security cryptocontroller, optimized for automotive applications
ISO 7816, SWP, I2C, SPI and GPIO's
1 MByte, 1332 kByte, 1536 kByte, 2 MByte
48 kByte
32-bit
AES up to 256-bit, DES, 3DES
ECC up to 521-bit, RSA up to 4096-bit
-40°C to +105°C
MFF2 (VQFN-8-4), VQFN-32-13
Automotive eSIM, eCall, V2X, Trust Anchor
CC EAL6+ high




SIM/eSIM Industrial

	eUICC industrial (M2M)			
Product name ³⁾	SLM 76CFxxx1P  SOLID FLASH™	SLM 76CF5120P  SOLID FLASH™	SLM 97CFxxx0PE  SOLID FLASH™	SLM 97CFXxxx0PE  SOLID FLASH™
Product description	Security controller, optimized for industrial applications (SIM)	Security controller, optimized for industrial applications (SIM)	Security controller, optimized for industrial applications (eSIM)	Security cryptocontroller, optimized for industrial applications (eSIM)
Interfaces	ISO 7816	ISO 7816	ISO 7816	ISO 7816
NVM	256, 320, 360 kByte	504 kByte	608, 800 kByte, 1 MByte	608, 800 kByte, 1 MByte
RAM	8 kByte	12 kByte	32 kByte	32 kByte
CPU	16-bit	16-bit	32-bit	32-bit
Symmetrical cryptography	AES up to 256-bit, DES, 3DES	AES up to 256-bit, DES, 3DES	–	AES up to 256-bit, DES, 3DES
Asymmetrical cryptography	–	–	–	ECC up to 521-bit, RSA up to 4096-bit
Ambient temperature	-40°C to +105°C	-40°C to +105°C	-40°C to +105°C	-40°C to +105°C
Delivery forms	MFF2, P-M2M4.7, sawn wafer	MFF2, P-M2M4.7, sawn wafer	MFF2, P-M2M4.7, sawn wafer, WF WLB-16	MFF2, P-M2M4.7, sawn wafer, WF WLB-16
Typical applications	–	–	–	–
Certifications	–	–	CC EAL5+ high	CC EAL5+ high









³⁾ Please note that xxx in product names stands for NVM size

SLM 97CNFxxx0PE  SOLID FLASH™	SLM 97CNFXxxx0PE  SOLID FLASH™	SLM 97CSINFxxx0PE  SOLID FLASH™	SLM17ECB800B  SOLID FLASH™ new	SLM16ECB240B  SOLID FLASH™ new
Security controller, optimized for industrial applications (eSIM, NFC-enabled)	Security cryptocontroller, optimized for industrial applications (eSIM, NFC-enabled)	Security cryptocontroller, optimized for industrial applications	Security cryptocontroller, optimized for industrial applications (M2M SIM and eSIM)	Security cryptocontroller, optimized for industrial applications (M2M SIM)
ISO 7816, SWP	ISO 7816, SWP	I2C, ISO 7816, SPI, SWP	ISO 7816, GPIO	ISO 7816
608, 800 kByte, 1 MByte	608, 800 kByte, 1 MByte	800 kByte, 1 MByte	800 kByte	240 kByte
32 kByte	32 kByte	32 kByte	20 kByte	12 kByte
32-bit	32-bit	32-bit	32-bit	32-bit
–	AES up to 256-bit, DES, 3DES	AES up to 256-bit, DES, 3DES	AES up to 256-bit, DES, 3DES	AES up to 256-bit, DES, 3DES
–	ECC up to 521-bit, RSA up to 4096-bit	ECC up to 521-bit, RSA up to 4096-bit	–	–
-40°C to +105°C	-40°C to +105°C	-40°C to +105°C	-40°C to +105°C	-40°C to +105°C
MFF2, P-M2M4.7, sawn wafer, WF WLB-16	MFF2, P-M2M4.7, sawn wafer, WF WLB-16	VQFN-32-13	MFF2, sawn wafer, USON-8-6, USON-6-2, USON-10-2, XFWLB-6-2	Sawn wafer, USON-8-5, USON-10-2, XFWLB-6-3
–	–	–	–	–
CC EAL5+ high	CC EAL5+ high	CC EAL5+ high	CC EAL5+ high	CC EAL5+ high










Near-Field Communication

	SWP UICCs		Embedded Secure Elements (eSE)
Product name ³⁾	SLE 97CUNFXxxx0PE  SOLID FLASH™	SLC37MWAxxx NFC™ Optimized  SOLID FLASH™ new	SLC37ESAxxx NFC™ Optimized  SOLID FLASH™
Product description	32-bit USB and SWP SIM card security cryptocontroller	32-bit USB and SWP SIM card security cryptocontroller	32-bit SWP security cryptocontroller for embedded secure element
Interfaces	ISO 7816, NRG™ (ISO/IEC 14443-3 type A with CRYPTO1), SWP, USB	GPIOs, ISO 7816, NRG™ (ISO/IEC 14443-3 type A with CRYPTO1), SPI, SWP, I2C, USB	GPIOs, ISO 7816, NRG (ISO/IEC 14443-3 type A with CRYPTO1), SPI, SWP
NVM	600, 800 kByte, 1, 1.3, 1.5 MByte	1.0, 1.2, 1.5, 2.0 MByte	1.2, 1.5, 2.0 MByte
RAM	32 kByte	48 kByte	48 kByte
ROM	-	-	-
CPU	32-bit	32-bit	32-bit
Symmetrical cryptography	AES up to 256-bit, DES, 3DES	AES up to 256-bit, DES, 3DES	AES up to 256-bit, DES, 3DES
Asymmetrical cryptography	ECC up to 521-bit, RSA up to 4096-bit	ECC up to 521-bit, RSA up to 4096-bit	ECC up to 521-bit, RSA up to 4096-bit
Ambient temperature	-25°C to +85°C	-25°C to +85°C	-25°C to +85°C
Delivery forms	SMD (VQFN-8), sawn wafer	Sawn wafer, CSP, SMD	CSP, SMD, sawn wafer
Typical applications	SIM and UICC for mobile communication	SIM and UICC for mobile communication	NFC embedded secure element - IC
Certifications	CC EAL5+ high, EMVCo	CC EAL6+ high, EMVCo	CC EAL6+ high, EMVCo





³⁾ Please note that xxx in product names stands for NVM size

Boosted NFC Secure Elements		
SLE 77CAFX2400P(M)	SLE 78CAFX1M1SPHM	SLE 78CAFX4000P(M)
 NFC Optimized  SOLID FLASH™	 Integrity Guard  NFC Optimized  SOLID FLASH™	 Integrity Guard  NFC Optimized  SOLID FLASH™
Security cryptocontroller designed for boosted NFC	Boosted NFC secure element (SE)	Boosted NFC secure element (SE)
ISO 7816, ISO 14443 A/B, ISO 18092 via ACLB interface and external active booster, optional NRG™ (ISO/IEC 14443-3 type A with CRYPTO1)	ACLB, I2C, ISO 7816, NRG™ (ISO/IEC 14443-3 type A with CRYPTO1)	ACLB, ISO 7816, NRG™ (ISO/IEC 14443-3 type A with CRYPTO1)
240 kByte	628 kByte	400 kByte
6 kByte	12 kByte	8 kByte
–	444 kByte	–
16-bit	Dual 16-bit	Dual 16-bit
DES, 3DES	AES up to 256-bit, DES, 3DES, ECC, RSA	AES up to 256-bit, DES, 3DES, ECC, RSA
ECC up to 521-bit, RSA up to 4096-bit	ECC up to 521-bit, RSA up to 4096-bit	ECC up to 521-bit, RSA up to 4096-bit
-25°C to +85°C	-25°C to +85°C	-25°C to +85°C
Sawn wafer	Sawn wafer	Sawn wafer
Secure element with ultra-small antenna for wearable or other smart devices	–	–
CC EAL5+ high, EMVCo	CC EAL6+ high, EMVCo	CC EAL6+ high, EMVCo








Near-Field Communication

	Boosted NFC Secure Elements		
Product name ⁴⁾	SLE 78CAF5xxxSPHM  Integrity Guard  Optimized  SOLID FLASH™	SLE 78CAF628SPHM  Integrity Guard  Optimized  SOLID FLASH™	SLE 78CAX5xxxSPHM  Integrity Guard  Optimized  SOLID FLASH™
Product description	Boosted NFC secure element (SE)	Boosted NFC secure element (SE)	Boosted NFC secure element (SE)
Interfaces	ACLB, GPIOs, ISO 7816, NRG™ (ISO/IEC 14443-3 type A with CRYPTO1), SPI	ACLB, I2C, ISO 7816, NRG™ (ISO/IEC 14443-3 type A with CRYPTO1)	ACLB, GPIOs, ISO 7816, NRG™ (ISO/IEC 14443-3 type A with CRYPTO1), SPI
NVM	500 kByte	628 kByte	500 kByte
RAM	8, 12, 18 kByte	12 kByte	8, 12, 18 kByte
ROM	–	–	182 kByte
CPU	Dual 16-bit	Dual 16-bit	Dual 16-bit
Symmetrical cryptography	AES up to 256-bit, DES, 3DES, ECC, RSA	AES up to 256-bit, DES, 3DES, ECC, RSA	AES up to 256-bit, DES, 3DES, ECC, RSA
Asymmetrical cryptography	ECC up to 521-bit, RSA up to 4096-bit	ECC up to 521-bit, RSA up to 4096-bit	ECC up to 521-bit, RSA up to 4096-bit
Ambient temperature	-25°C to +85°C	-25°C to +85°C	-25°C to +85°C
Delivery forms	Sawn wafer	Sawn wafer	Sawn wafer
Typical applications	–	–	–
Certifications	CC EAL6+ high, EMVCo	CC EAL6+ high, EMVCo	CC EAL6+ high, EMVCo


















⁴⁾ Please note that xxx in product names stands for RAM size

	NFC tags	
Product name	SLE 66R01LN  Ready 	SLE 66R01PN  Ready 
Product description	my-d™ move lean NFC, pre-configured NFC memory, NFC Forum Type 2 Tag certified	my-d™ move NFC, pre-configured NFC memory, NFC Forum Type 2 Tag certified
Interfaces	ISO/IEC 14443-3 Type A, NFC Forum Type 2 Tag operation	ISO/IEC 14443-3 Type A, NFC Forum Type 2 Tag operation
Memory organization	1 fixed sector, pre-configured NFC memory	1 fixed sector, pre-configured NFC memory
Counter	–	16-bit counter, anti-tearing support
EEPROM	48 byte (user), 24 byte (admin)	128 byte (user), 24 byte (admin)
Security features	Block locking, individual page locking, unique serial number	32-bit password protection for read and/or write access, block locking, individual page locking, password retry counter, unique serial number
Distance (read/write)	Typically up to 10 cm and above	Typically up to 10 cm and above
Data rate	106 kbit/s to card, 106 kbit/s to reader	106 kbit/s to card, 106 kbit/s to reader
Endurance	10000	10000
Retention time	>5 years	>5 years
Tools	Evaluation kit contactless	Evaluation kit contactless
Delivery forms	NiAu-bump, sawn wafer	NiAu-bump, sawn wafer
Typical applications	NFC device pairing, smart posters, consumer goods information	NFC device pairing, smart posters, consumer goods information
Certifications	NFC Forum Type 2 Tag	NFC Forum Type 2 Tag










Government Identification

	Dual-interface & contactless security controllers			
Product name ³⁾	SLE 77CLF1001P  SOLID FLASH™	SLE 77CLFxxx0PH  SOLID FLASH™	SLE 78CLFXxxx0PH  Integrity Guard  SOLID FLASH™	SLE 78CLFXxxx0PH  Integrity Guard  SOLID FLASH™  Mega Memory
Product description	Contactless security controller	Contactless security cryptocontroller with dual-interface	Contactless security cryptocontroller with dual-interface	Contactless security cryptocontroller with dual-interface
Interfaces	ISO 14443 A/B, ISO 18092 passive mode, NRG™ (ISO/IEC 14443-3 type A with CRYPTO1)	ISO 14443 A/B, ISO 18092 passive mode, ISO 7816, NRG™ (ISO/IEC 14443-3 type A with CRYPTO1)	ISO 14443 A/B, ISO 18092 passive mode, ISO 7816, NRG™ (ISO/IEC 14443-3 type A with CRYPTO1)	ISO 14443 A/B, ISO 18092 passive mode, ISO 7816, NRG™ (ISO/IEC 14443-3 type A with CRYPTO1)
NVM	100 kByte	200, 240 kByte	240, 300, 404 kByte	528, 628 kByte
RAM	4 kByte	6 kByte	8 kByte	12 kByte
ROM	–	–	–	–
CPU	16-bit	16-bit	Dual 16-bit	Dual 16-bit
Symmetrical cryptography	AES up to 256-bit, DES, 3DES	AES up to 256-bit, DES, 3DES	AES up to 256-bit, DES, 3DES	AES up to 256-bit, DES, 3DES
Asymmetrical cryptography	–	ECC up to 521-bit, RSA up to 4096-bit	ECC up to 521-bit, RSA up to 4096-bit	ECC up to 521-bit, RSA up to 4096-bit
Ambient temperature	-25°C to +85°C	-25°C to +85°C	-25°C to +85°C	-25°C to +85°C
Delivery forms	Sawn wafer, contactless module	Sawn wafer, contactless module, dual-interface module	Sawn wafer, contactless module, dual-interface module	Sawn wafer, contactless module, dual-interface module
Typical applications	National eID, eHealth card / eSocial card, eDriver's license, eVehicle registration card / eCar registration	National eID, eHealth card / eSocial card, eDriver's license, eVehicle registration card / eCar registration	National eID, ePassport, eHealth card / eSocial card, eDriver's license, eVisa, eResidence permit, eTachograph, eVehicle registration card / eCar registration, eSignature	National eID, ePassport, eHealth card / eSocial card, eDriver's license, eVisa, eResidence permit, eTachograph, eVehicle registration card / eCar registration, eSignature
Certifications	CC EAL5+ high	CC EAL5+ high	CC EAL6+ high, EMVCo	CC EAL6+ high, EMVCo















³⁾ Please note that xxx in product names stands for NVM size

SLE 78CLFXxxxVPH  Integrity Guard  SOLID FLASH™  VHBR	SLE 78CLFXxxxVPH  Integrity Guard  SOLID FLASH™  VHBR  Mega Memory	SLE 78CLFX1M10PH  Integrity Guard  SOLID FLASH™  Mega Memory	SLE 78CLFX1M1VPH  Integrity Guard  SOLID FLASH™  VHBR  Mega Memory	SLC52GDAXxx  Integrity Guard  SOLID FLASH™  VHBR
Contactless security cryptocontroller with dual-interface	Contactless security cryptocontroller with dual-interface	Contactless security cryptocontroller with dual-interface	Contactless security cryptocontroller with dual-interface	Contactless security cryptocontroller with dual-interface
ISO 14443 A/B, ISO 18092 passive mode, ISO 7816, NRG™ (ISO/IEC 14443-3 type A with CRYPTO1)	ISO 14443 A/B, ISO 18092 passive mode, ISO 7816, NRG™ (ISO/IEC 14443-3 type A with CRYPTO1)	ISO 14443 A/B, ISO 18092 passive mode, ISO 7816, NRG™ (ISO/IEC 14443-3 type A with CRYPTO1)	ISO 14443 A/B, ISO 18092 passive mode, ISO 7816, NRG™ (ISO/IEC 14443-3 type A with CRYPTO1)	ISO 14443 A/B, ISO 18092 passive mode, ISO 7816, NRG™ (ISO/IEC 14443-3 type A with CRYPTO1)
300, 404 kByte	528, 628 kByte	628 kByte	628 kByte	248, 348, 448 kBytes
8 kByte	12 kByte	12 kByte	12 kByte	12 kByte
-	-	444 kByte	444 kByte	-
Dual 16-bit	Dual 16-bit	Dual 16-bit	Dual 16-bit	Dual 16-bit
AES up to 256-bit, DES, 3DES	AES up to 256-bit, DES, 3DES	AES up to 256-bit, DES, 3DES	AES up to 256-bit, DES, 3DES	AES up to 256-bit, DES, 3DES
ECC up to 521-bit, RSA up to 4096-bit	ECC up to 521-bit, RSA up to 4096-bit	ECC up to 521-bit, RSA up to 4096-bit	ECC up to 521-bit, RSA up to 4096-bit	ECC up to 521-bit, RSA up to 4096-bit
-25°C to +85°C	-25°C to +85°C	-25°C to +85°C	-25°C to +85°C	-25°C to +85°C
Sawn wafer, contactless module, dual-interface module	Sawn wafer, contactless module, dual-interface module	Sawn wafer, contactless module, dual-interface module	Sawn wafer, contactless module, dual-interface module	Sawn wafer, contactless module, dual-interface module
National eID, ePassport, eHealth card / eSocial card, eDriver's license, eVisa, eResidence permit, eTachograph, eVehicle registration card / eCar registration, eSignature	National eID, ePassport, eHealth card / eSocial card, eDriver's license, eVisa, eResidence permit, eTachograph, eVehicle registration card / eCar registration, eSignature	National eID, ePassport, eHealth card / eSocial card, eDriver's license, eVisa, eResidence permit, eTachograph, eVehicle registration card / eCar registration, eSignature	National eID, ePassport, eHealth card / eSocial card, eDriver's license, eVisa, eResidence permit, eTachograph, eVehicle registration card / eCar registration, eSignature	National eID, ePassport, eHealth card / eSocial card, eDriver's license, eVisa, eResidence permit, eTachograph, eVehicle registration card / eCar registration, eSignature
CC EAL6+ high, EMVCo	CC EAL6+ high, EMVCo	CC EAL6+ high, EMVCo	CC EAL6+ high, EMVCo	CC EAL6+ high, EMVCo

Government Identification










	Contactless security controllers			Contact-based security controllers
Product name ³⁾	SLC52GDAxxx  Integrity Guard  SOLID FLASH™  VHBR  Mega Memory	SLC37GDAxxx new  SOLID FLASH™  VHBR	SLC37GCB240  SOLID FLASH™	SLE 78CFxxx0PH  Integrity Guard  SOLID FLASH™
Product description	Contactless security cryptocontroller with dual-interface	Contactless security cryptocontroller with dual-interface	Security controller	Security cryptocontroller
Interfaces	ISO 14443 A/B, ISO 18092 passive mode, ISO 7816, NRG™ (ISO/IEC 14443-3 type A with CRYPTO1)	ISO 14443 A/B, ISO 18092 passive mode, ISO 7816, NRG™ (ISO/IEC 14443-3 type A with CRYPTO1)	ISO 7816	ISO 7816
NVM	600, 700, 804 kBytes	448, 512 kBytes	240 kByte	240, 300, 404 kByte
RAM	16 kByte	16 kByte	12 kByte	8 kByte
ROM	–	–	–	–
CPU	Dual 16-bit	32-bit Arm® SecurCore® SC300	32-bit Arm® SecurCore® SC300	Dual 16-bit
Symmetrical cryptography	AES up to 256-bit, DES, 3DES	AES up to 256-bit, DES, 3DES	AES, DES	AES up to 256-bit, DES, 3DES
Asymmetrical cryptography	ECC up to 521-bit, RSA up to 4096-bit	ECC up to 521-bit, RSA up to 4096-bit	–	ECC up to 521-bit, RSA up to 4096-bit
Ambient temperature	-25°C to +85°C	-25°C to +85°C	-25°C to +85°C	-25°C to +85°C
Delivery forms	Sawn wafer, contactless module, dual-interface module	Sawn wafer, contactless module, dual-interface module	Sawn wafer, contact-based module	Sawn wafer, contact-based module
Typical applications	National eID, ePassport, eHealth card / eSocial card, eDriver's license, eVisa, eResidence permit, eTachograph, eVehicle registration card / eCar registration, eSignature	National eID, ePassport, eHealth card / eSocial card, eDriver's license, eVisa, eResidence permit, eTachograph, eVehicle registration card / eCar registration, eSignature	National eID, eHealth card / eSocial card	National eID, eHealth card / eSocial card, eDriver's license, eTachograph, eVehicle registration card / eCar registration, eSignature
Certifications	CC EAL6+ high, EMVCo	Targeted CC EAL6+ high, EMVCo	CC EAL5+ high	CC EAL6+ high, EMVCo

³⁾ Please note that xxx in product names stands for NVM size

SLE 78CFXxx0PH	SLE 78CFX1M10PH	SLC52GCAxxx	SLC52GCAxxx	SLC37GCAxxx new
 Integrity Guard  SOLID FLASH™  Mega Memory	 Integrity Guard  SOLID FLASH™  Mega Memory	 Integrity Guard  SOLID FLASH™  Mega Memory	 Integrity Guard  SOLID FLASH™  Mega Memory	 SOLID FLASH™  Mega Memory
Security cryptocontroller	Security cryptocontroller	Security cryptocontroller	Security cryptocontroller	Security cryptocontroller
ISO 7816	ISO 7816	ISO 7816	ISO 7816	ISO 7816
528, 628 kByte	628 kByte	200, 300, 448 kByte	600, 700, 804 kByte	448, 512 kByte
12 kByte	12 kByte	12 kByte	16 kByte	16 kByte
–	444 kByte	–	–	–
Dual 16-bit	Dual 16-bit	Dual 16-bit	Dual 16-bit	32-bit Arm® SecurCore® SC300
AES up to 256-bit, DES, 3DES	AES up to 256-bit, DES, 3DES	AES up to 256-bit, DES, 3DES	AES up to 256-bit, DES, 3DES	AES up to 256-bit, DES, 3DES
ECC up to 521-bit, RSA up to 4096-bit	ECC up to 521-bit, RSA up to 4096-bit	ECC up to 521-bit, RSA up to 4096-bit	ECC up to 521-bit, RSA up to 4096-bit	ECC up to 521-bit, RSA up to 4096-bit
-25°C to +85°C	-25°C to +85°C	-25°C to +85°C	-25°C to +85°C	-25°C to +85°C
Sawn wafer, contact-based module	Sawn wafer, contact-based module	Sawn wafer, contact-based module	Sawn wafer, contact-based module	Sawn wafer, contact-based module
National eID, eHealth card / eSocial card, eDriver's license, eTachograph, eVehicle registration card / eCar registration, eSignature	National eID, eHealth card / eSocial card, eDriver's license, eTachograph, eVehicle registration card / eCar registration, eSignature	National eID, eHealth card / eSocial card, eDriver's license, eTachograph, eVehicle registration card / eCar registration, eSignature	National eID, eHealth card / eSocial card, eDriver's license, eTachograph, eVehicle registration card / eCar registration, eSignature	National eID, eHealth card / eSocial card, eDriver's license, eTachograph, eVehicle registration card / eCar registration, eSignature
CC EAL6+ high, EMVCo	CC EAL6+ high, EMVCo	CC EAL6+ high, EMVCo	CC EAL6+ high, EMVCo	Targeted CC EAL6+ high, EMVCo










⁵⁾ Please note that xxx in product names stands for NVM size

Government Identification Solutions









	Java Card™ platform on SLE 78			
Product name ⁵⁾	SLJ 52GLLxxxCR  Integrity Guard  SOLID FLASH™	SLJ 52GCAxxxCR  Integrity Guard  SOLID FLASH™	SLJ 52GDAxxxCC  Integrity Guard  SOLID FLASH™	SLJ 52GDAxxxVC  Integrity Guard  SOLID FLASH™  VHBR
Product description	Java Card platform	Java Card platform	Java Card platform	Java Card platform
Communication interfaces	ISO 14443 A/B, NRG™ (ISO/IEC 14443-3 type A with CRYPTO1)	ISO 7816	ISO 14443 A/B, ISO 7816	ISO 14443 A/B, ISO 7816
Supported standards	GP2.2.1, JC3.0	GP2.2.1, JC3.0	GP2.2.1, JC3.0	GP2.2.1, JC3.0
NVM	36, 80, 128 kByte	36, 80, 128 kByte	36, 80, 128 kByte	36, 80, 128 kByte
Operating system	Oracle (Oracle JCOS Edition 1)	Oracle (Oracle JCOS Edition 1)	Oracle (Oracle JCOS Edition 2)	Oracle (Oracle JCOS Edition 2)
Symmetrical cryptography	AES up to 256-bit, DES, 3DES	AES up to 256-bit, DES, 3DES	AES up to 256-bit, DES, 3DES	AES up to 256-bit, DES, 3DES
Asymmetrical cryptography	ECC up to 521-bit, RSA up to 3072-bit	ECC up to 521-bit, RSA up to 3072-bit	ECC up to 521-bit, RSA up to 2048-bit	ECC up to 521-bit, RSA up to 2048-bit
Typical applications	All applications such as national eID, ePassport, eHealth card / eSocial Security card, eDriver's License, eVisa, eResidence permit, eTachograph, eVehicle registration card, eSignature	All applications such as national eID, ePassport, eHealth card / eSocial card, eDriver's license, eVisa, eResidence permit, eTachograph, eVehicle registration card / eCar registration, eSignature	All applications such as national eID, ePassport, eHealth card / eSocial card, eDriver's license, eVisa, eResidence permit, eTachograph, eVehicle registration card / eCar registration, eSignature	All applications such as national eID, ePassport, eHealth card / eSocial card, eDriver's license, eVisa, eResidence permit, eTachograph, eVehicle registration card / eCar registration, eSignature
Certifications	CC EAL5+ high, FIPS 140-2	CC EAL5+ high, FIPS 140-2	CC EAL5+ high	CC EAL5+ high

⁵⁾ Please note that xxx in product names stands for NVM size
















Java Card™ platform on SLE 78 with applet

SLJ 52GCA080BL  Integrity Guard	SLJ 52GDA080BL  Integrity Guard	SLJ 52GCA080BR  Integrity Guard  SOLID FLASH™	SLJ 52GCA080BC  Integrity Guard  SOLID FLASH™	SLJ 52GDA080RC  Integrity Guard  SOLID FLASH™  VHBR
Java Card platform including eDriver's License (eMRTD applet)	Java Card platform including eDriver's License (eMRTD applet)	Java Card platform including eDriver's License (eMRTD applet)	Java Card platform including eDriver's License (eMRTD applet)	Java Card platform including eDriver's License (eMRTD applet)
ISO 7816	ISO 14443 A/B, ISO 7816	ISO 7816	ISO 7816	ISO 14443 A/B, ISO 7816
ISO 18013 BAP, EAP config 1-4, ISO 7816-4, 8, 9	ISO 18013 BAP, EAP config 1-4, ISO 7816-4, 8, 9	ISO 18013 BAP, EAP config 1-4, ISO 7816-4, 8, 9	ISO 18013 BAP, EAC, SAC, ISO 7816-4, 8, 9	ISO 18013 BAP, EAC, SAC, ISO 7816-4, 8, 9
80 kByte	80 kByte	80 kByte	80 kByte	80 kByte
Trusted Logic (jTOP ID)	Trusted Logic (jTOP ID)	Oracle (Oracle JCOS I)	Oracle (Oracle JCOS Edition 2)	Oracle (Oracle JCOS Edition 2)
AES up to 256-bit, DES, 3DES	AES up to 256-bit, DES, 3DES	AES up to 256-bit, DES, 3DES	AES up to 256-bit, DES, 3DES	AES up to 256-bit, DES, 3DES
ECC up to 521-bit, RSA up to 2048-bit	ECC up to 521-bit, RSA up to 2048-bit	ECC up to 384-bit, RSA up to 1536-bit	ECC up to 384-bit, RSA up to 1536-bit	ECC up to 384-bit, RSA up to 1536-bit
eDriver's license	eDriver's license	eDriver's license	eDriver's license	eDriver's license
-	-	-	-	-











Government Identification Solutions

	Java Card™ platform on SLE 78 with applet			
Product name	SLJ 52GDA128AL  Integrity Guard	SLJ 52GLA080AR  Integrity Guard  SOLID FLASH™	SLJ 52GDA080HC  Integrity Guard  SOLID FLASH™  VHBR	SLJ 52GCA080DC  Integrity Guard  SOLID FLASH™
Product description	Java Card platform including eMRTD applet	Java Card platform including eMRTD applet	Java Card platform including eMRTD applet	Java Card platform including PKI applet
Communication interfaces	ISO 14443 A/B, ISO 7816	ISO 14443 A/B	ISO 14443 A/B, ISO 7816	ISO 7816
Supported standards	ICAO BAC, EAC, SAC, ISO 7816-4, 8, 9	ICAO BAC, EAC, SAC, ISO 7816-4, 8, 9	ICAO BAC, EAC, SAC, ISO 7816-4, 8, 9	ICAO EAC, SAC, PKCS#15
NVM	128 kByte	80 kByte	80 kByte	80 kByte
Operating system	Trusted Logic (jTOP ID)	Oracle (Oracle JCOS Edition 1)	Oracle (Oracle JCOS Edition 2)	Oracle (Oracle JCOS Edition 1)
Symmetrical cryptography	AES up to 256-bit, DES, 3DES	AES up to 256-bit, DES, 3DES	AES up to 256-bit, DES, 3DES	AES up to 256-bit, DES, 3DES
Asymmetrical cryptography	ECC up to 521-bit, RSA up to 2048-bit	ECC up to 384-bit, RSA up to 1536-bit	ECC up to 384-bit, RSA up to 1536-bit	ECC up to 384-bit, RSA up to 2048-bit
Typical applications	ePassport, eResidence permit, eidentity card	ePassport, eResidence permit, eidentity card	ePassport, eResidence permit, eidentity card	eAuthentication, eHealthcare, eSignature, eWelfare social security, secured file transfer
Certifications	CC EAL4+ high	-	-	-








⁶ Please note that xxx in product names stands for NVM size

SECORA™ ID Java Card™ platform on SLC 52				
SLJ 52GDA080KC  Integrity Guard  SOLID FLASH™  VHBR	SLJ 52GDTxxxCS new  Integrity Guard  SOLID FLASH™  VHBR	SLJ 52GDT120VS new  Integrity Guard  SOLID FLASH™  VHBR	SLJ 52GLT120CS new  Integrity Guard  SOLID FLASH™  VHBR	SLJ 52GDA110CS new  Integrity Guard  SOLID FLASH™  VHBR
Java Card platform including PKI applet	Java Card platform with Eclipse development tool	Java Card platform with Eclipse development tool	Java Card platform with Eclipse development tool	Java Card platform with Eclipse development tool
ISO 14443 A/B, ISO 7816	ISO 14443 A/B, ISO 7816	ISO 14443 A/B, ISO 14443 VHBR, ISO 7816	ISO 14443 A/B, ISO 7816	ISO 14443 A/B, ISO 7816
ICAO EAC, SAC, PKCS#15	GP 2.3.1, JC 3.0.5	GP 2.3.1, JC 3.0.5	GP 2.3.1, JC 3.0.5	GP 2.3.1, JC 3.0.5
80 kByte	80, 120 kByte	120 kByte	120 kByte	110 kByte
Oracle (Oracle JCOS Edition 2)	SECORA™ ID S Version 1.0	SECORA™ ID S Version 1.0	SECORA™ ID S Version 1.0	SECORA™ ID S Version 1.0
AES up to 256-bit, DES, 3DES	AES up to 256-bit, 3DES	AES up to 256-bit, 3DES	AES up to 256-bit, 3DES	AES up to 256-bit, 3DES
ECC up to 384-bit, RSA up to 2048-bit	ECC up to 521-bit, RSA up to 2048-bit	ECC up to 521-bit, RSA up to 2048-bit	ECC up to 521-bit, RSA up to 2048-bit	ECC up to 521-bit, RSA up to 4096-bit
eAuthentication, eHealthcare, eSignature, eWelfare social security, secured file transfer	National eID, ePassport, eHealth card, eDriver's License, eSignature, ISO 7816-4 data structure for customization	National eID, ePassport, eHealth card, eDriver's License, eSignature, ISO 7816-4 data structure for customization	National eID, ePassport, eHealth card, eDriver's License, eSignature, ISO 7816-4 data structure for customization	National eID, ePassport, eHealth card, eDriver's License, eSignature, ISO 7816-4 data structure for customization
-	CC EAL6+ high, EMVCo targeted	CC EAL6+ high, EMVCo targeted	CC EAL6+ high, EMVCo targeted	CC EAL6+ high, EMVCo targeted




Government Identification Solutions

	SECORA™ ID Java Card™ platform on SLC 52		SECORA™ ID Java Card™ platform with applet on SLC 52	
Product name	SLJ 52GLA110CS new  Integrity Guard  SOLID FLASH™	SLJ 52GDA110VS new  Integrity Guard  SOLID FLASH™  VHBR	SLJ 52GDAxxxRS new  Integrity Guard  SOLID FLASH™	SLJ 52GDAxxxYS new  Integrity Guard  SOLID FLASH™  VHBR
Product description	Java Card platform with Eclipse development tool	Java Card platform with Eclipse development tool	Applet Collection by Masktech GmbH, Java Card platform including eMRTD applet (ICAO)	Applet Collection by Masktech GmbH, Java Card platform including eMRTD applet (ICAO)
Communication interfaces	ISO 14443 A/B, ISO 7816	ISO 14443 A/B, ISO 14443 VHBR, ISO 7816	ISO 14443 A/B, ISO 7816	ISO 14443 A/B, ISO 14443 VHBR, ISO 7816
Supported standards	GP 2.3.1, JC 3.0.5	GP 2.3.1, JC 3.0.5	GP 2.3.1, JC 3.0.5	GP 2.3.1, JC 3.0.5
NVM	110 kByte	110 kByte	xxx kByte	xxx kByte
Operating system	SECORA™ ID S Version 1.0	SECORA™ ID S Version 1.0	SECORA™ ID S Version 1.0	SECORA™ ID S Version 1.0
Symmetrical cryptography	AES up to 256-bit, 3DES	AES up to 256-bit, 3DES	AES up to 256-bit, 3DES	AES up to 256-bit, 3DES
Asymmetrical cryptography	ECC up to 521-bit, RSA up to 4096-bit	ECC up to 521-bit, RSA up to 4096-bit	ECC up to xxx-bit, RSA up to xxxx-bit	ECC up to xxx-bit, RSA up to xxxx-bit
Typical applications	National eID, ePassport, eHealth card, eDriver's License, eSignature, ISO 7816-4 data structure for customization	National eID, ePassport, eHealth card, eDriver's License, eSignature, ISO 7816-4 data structure for customization	National eID, ePassport, eHealth card, eDriver's License, eSignature, ISO 7816-4 data structure for customization	National eID, ePassport, eHealth card, eDriver's License, eSignature, ISO 7816-4 data structure for customization
Certifications	CC EAL6+ high, EMVCo targeted	CC EAL6+ high, EMVCo targeted	eMRTD CC EAL5+ high targeted	eMRTD CC EAL5+ high targeted

© Please note that xxx in product names stands for EEPROM size, y specifies an application (e.g. eAuthentication, eHealthcare, eSignature, etc.)

SLJ 52GDT080AS new  Integrity Guard  SOLID FLASH™	SLJ 52GDT080HS new  Integrity Guard  SOLID FLASH™  VHBR	SLJ 52GDAxxxNS new  Integrity Guard  SOLID FLASH™
Infineon Applet Collection eMRTD V1.0, Java Card platform including eMRTD applet (ICAO)	Infineon Applet Collection eMRTD V1.0, Java Card platform including eMRTD applet (ICAO)	Applet Collection by Masktech GmbH, Java Card platform including ePKI applet
ISO 14443 A/B, ISO 7816	ISO 14443 A/B, ISO 14443 VHBR, ISO 7816	ISO 14443 A/B, ISO 7816
GP 2.3.1, JC 3.0.5	GP 2.3.1, JC 3.0.5	GP 2.3.1, JC 3.0.5
80 kByte	80 kByte	xxx kByte
SECORA™ ID S Version 1.0	SECORA™ ID S Version 1.0	SECORA™ ID S Version 1.0
AES up to 256-bit, 3DES	AES up to 256-bit, 3DES	AES up to 256-bit, 3DES
ECC up to 521-bit, RSA up to 2048-bit	ECC up to 521-bit, RSA up to 2048-bit	ECC up to xxx-bit, RSA up to xxxx-bit
National eID, ePassport, eHealth card, eDriver's License, eSignature, ISO 7816-4 data structure for customization	National eID, ePassport, eHealth card, eDriver's License, eSignature, ISO 7816-4 data structure for customization	National eID, ePassport, eHealth card, eDriver's License, eSignature, ISO 7816-4 data structure for customization
eMRTD CC EAL5+ high targeted	eMRTD CC EAL5+ high targeted	ePKI CC EAL5+ high targeted









Government Identification Solutions

	Native MTCOS ID 2.5 platform on SLE 78
Product name ⁶⁾	SLN 52GDAxxxK  Integrity Guard  SOLID FLASH™  VHBR
Product description	Native MTCOS ID 2.5 platform including ePass, eDriver's license and eSign use case
Communication interfaces	ISO 14443 A/B, ISO 7816
Supported standards	BSI-TR03110 v1.11 and v2.05 EAC, ICAO BAC, SAC, AA, ISO 18013 BAP, EAP config 1-4, ISO 7816-4, 8, 9, PKCS#15
NVM	36, 80, 128 kByte
Operating system	Masktech (MTCOS ID 2.5)
Symmetrical cryptography	AES up to 256-bit, DES, 3DES
Asymmetrical cryptography	ECC up to 521-bit, RSA up to 4096-bit
Typical applications	eAuthentication, eDriver's license, eHealthcare, eIdentity card, ePassport, eSignature, eWelfare social security, secured file transfer
Certifications	ePass eSign CC EAL5+ high









⁶⁾ Please note that xxx in product names stands for NVM size, y specifies an application (e.g. eAuthentication, eHealthcare, eSignature, etc.)








USB Tokens

	USB tokens (16-bit)			
Product name ³⁾	SLE 78CUFXxxx9PH  Integrity Guard  SOLID FLASH™	SLE 78CUFX3000PH  Integrity Guard  SOLID FLASH™	SLE 78CLUFX3000PH  Integrity Guard  SOLID FLASH™	SLE 78CLUFX5000PH  Integrity Guard  SOLID FLASH™
Product description	USB security cryptocontroller for use in chipcard form factor	USB security cryptocontroller	Multi-interface USB security cryptocontroller with a contactless interface	Multi-interface USB security cryptocontroller with a contactless interface
Interfaces	ISO 7816, USB 2.0	4 GPIOs, ISO 7816, USB 2.0	4 GPIOs, I2C, ISO 14443 A/B, ISO 18092 passive mode, ISO 7816, NRG™ (ISO/IEC 14443-3 type A with CRYPTO1), USB 2.0	12 GPIOs, I2C, ISO 14443 A/B, ISO 18092 passive mode, ISO 7816, NRG™ (ISO/IEC 14443-3 type A with CRYPTO1), SPI, USB 2.0
NVM	300, 500 kByte	300 kByte	300 kByte	500 kByte
RAM	12 kByte	12 kByte	12 kByte	16 kByte
ROM	-	-	-	-
CPU	Dual 16-bit	Dual 16-bit	Dual 16-bit	Dual 16-bit
Crypto coprocessor symmetrical	AES up to 256-bit, DES, 3DES	AES up to 256-bit, DES, 3DES	AES up to 256-bit, DES, 3DES	AES up to 256-bit, DES, 3DES
Crypto coprocessor asymmetrical	ECC up to 521-bit, RSA up to 4096-bit	ECC up to 521-bit, RSA up to 4096-bit	ECC up to 521-bit, RSA up to 4096-bit	ECC up to 521-bit, RSA up to 4096-bit
Ambient temperature	-25°C to +85°C	-25°C to +85°C	-25°C to +85°C	-25°C to +85°C
Delivery forms	Sawn wafer	VQFN-32, sawn wafer	VQFN-32, sawn wafer	VQFN-32, sawn wafer
Certifications	CC EAL6+ high, EMVCo	CC EAL6+ high, EMVCo	CC EAL6+ high, EMVCo	CC EAL6+ high, EMVCo







³⁾ Please note that xxx in product names stands for NVM size

SLE 78CLUFX5007PH  Integrity Guard  SOLID FLASH™	SLE 78CLUX5000PH  Integrity Guard  SOLID FLASH™	SLE 78CLUX5007PH  Integrity Guard  SOLID FLASH™	SLE 78CUFX5000PH  Integrity Guard  SOLID FLASH™
Multi-interface USB security cryptocontroller with a contactless interface	Multi-interface USB security cryptocontroller with a contactless interface	Multi-interface USB security cryptocontroller with a contactless interface	Multi-interface USB security cryptocontroller
12 GPIOs, I2C, ISO 14443 A/B, ISO 18092 passive mode, ISO 7816, NRG™ (ISO/IEC 14443-3 type A with CRYPTO1), SPI, USB 2.0, optimized for sub-ID1	12 GPIOs, I2C, ISO 14443 A/B, ISO 18092 passive mode, ISO 7816, NRG™ (ISO/IEC 14443-3 type A with CRYPTO1), SPI, USB 2.0	12 GPIOs, I2C, ISO 14443 A/B, ISO 18092 passive mode, ISO 7816, NRG™ (ISO/IEC 14443-3 type A with CRYPTO1), SPI, USB 2.0, optimized for sub-ID1	12 GPIOs, I2C, ISO 7816, SPI, USB 2.0
500 kByte	500 kByte	500 kByte	500 kByte
16 kByte	16 kByte	16 kByte	16 kByte
–	182 kByte	182 kByte	–
Dual 16-bit	Dual 16-bit	Dual 16-bit	Dual 16-bit
AES up to 256-bit, DES, 3DES	AES up to 256-bit, DES, 3DES	AES up to 256-bit, DES, 3DES	AES up to 256-bit, DES, 3DES
ECC up to 521-bit, RSA up to 4096-bit	ECC up to 521-bit, RSA up to 4096-bit	ECC up to 521-bit, RSA up to 4096-bit	ECC up to 521-bit, RSA up to 4096-bit
-25°C to +85°C	-25°C to +85°C	-25°C to +85°C	-25°C to +85°C
VQFN-32, sawn wafer	VQFN32, sawn wafer	VQFN-32, sawn wafer	VQFN-32, sawn wafer
CC EAL6+ high, EMVCo	CC EAL6+ high, EMVCo	CC EAL6+ high, EMVCo	CC EAL6+ high, EMVCo




USB Tokens

	USB tokens (32-bit)			
Product name ³⁾	SLE 97CUX500FPH  SOLID FLASH™	SLE 97CUX5000PH  SOLID FLASH™	SLE 97CUSIFX1M00PH  SOLID FLASH™  Mega Memory	SLE 97CUNSIFX1M00PH  SOLID FLASH™
Product description	USB security cryptocontroller for use in chipcard form factor	USB security cryptocontroller	Multi-interface USB security cryptocontroller	Multi-interface USB security cryptocontroller for industrial use
Interfaces	ISO 7816, USB 2.0	ISO 7816, USB 2.0	4 GPIOs, I2C, ISO 7816, SPI, USB 2.0	I2C, SPI, USB 2.0, SWP
NVM	504 kByte	504 kByte	1 MByte	1 MByte
RAM	20 kByte	20 kByte	32 kByte	32 kByte
CPU	32-bit	32-bit	32-bit	32-bit
Crypto coprocessor symmetrical	AES up to 256-bit, DES, 3DES	AES up to 256-bit, DES, 3DES	AES up to 256-bit, DES, 3DES	AES up to 256-bit, DES, 3DES
Crypto coprocessor asymmetrical	ECC up to 521-bit, RSA up to 4096-bit	ECC up to 521-bit, RSA up to 4096-bit	ECC up to 521-bit, RSA up to 4096-bit	ECC up to 521-bit, RSA up to 4096-bit
Ambient temperature	-25°C to +85°C	-25°C to +85°C	-25°C to +85°C	-25°C to +85°C
Delivery forms	Sawn wafer	Sawn wafer, VQFN-32, VQFN-8, USON 8	VQFN-32, sawn wafer	VQFN-32, sawn wafer
Certifications	CC EAL5+ high, EMVCo	CC EAL5+ high, EMVCo	CC EAL5+ high, EMVCo	CC EAL5+ high, EMVCo









³⁾ Please note that xxx in product names stands for NVM size

SLM 97CUSIFX1M00PH  SOLID FLASH™  Mega Memory	SLM 97CUNSIFX1M00PH  SOLID FLASH™  Mega Memory	SLE 97CUSIFXxxx0PH  SOLID FLASH™	SLM 97CUSIFXxxx0PH  SOLID FLASH™
Multi-interface USB security cryptocontroller for industrial use	Multi-interface USB security cryptocontroller for industrial use	Multi-interface USB security cryptocontroller	Multi-interface USB security cryptocontroller for industrial use
4 GPIOs, I2C, ISO 7816, SPI, USB 2.0	I2C, SPI, USB 2.0, SWP	4 GPIOs, I2C, ISO 7816, SPI, USB 2.0	4 GPIOs, I2C, ISO 7816, SPI, USB 2.0
1 MByte	1 MByte	504, 792 kByte	504, 792 kByte
32 kByte	32 kByte	24 kByte	24 kByte
32-bit	32-bit	32-bit	32-bit
AES up to 256-bit, DES, 3DES	AES up to 256-bit, DES, 3DES	AES up to 256-bit, DES, 3DES	AES up to 256-bit, DES, 3DES
ECC up to 521-bit, RSA up to 4096-bit	ECC up to 521-bit, RSA up to 4096-bit	ECC up to 521-bit, RSA up to 4096-bit	ECC up to 521-bit, RSA up to 4096-bit
-40°C to +105°C	-40°C to +105°C	-25°C to +85°C	-40°C to +105°C
VQFN-32, sawn wafer	VQFN-32, sawn wafer	VQFN-32, sawn wafer	VQFN-32, sawn wafer
CC EAL5+ high, EMVCo	CC EAL5+ high, EMVCo	CC EAL5+ high, EMVCo	CC EAL5+ high, EMVCo

Transport Ticketing



	Security products with integrated CIPURSE™ functionality		
Product name ⁵⁾	SLM 10TLC002L 	SLS 32TLCxxxS(M) 	SLS 32TLC100(M) 
Product description	CIPURSE™move	CIPURSE™4move	CIPURSE™Security controller
Interfaces	ISO 14443 A, NFC Forum Type 4 Tag configurable	ISO 14443 A, NRG™ (ISO/IEC 14443-3 type A with CRYPTO1) optional, NFC Forum Type 4 Tag configurable	ISO 14443 A, NRG™ (ISO/IEC 14443-3 type A with CRYPTO1) optional, NFC Forum Type 4 Tag configurable
Integrated CIPURSE™ functionality	Security architecture of CIPURSE™, built-in command set based on ISO 7816-4/-9, fully configurable file system based on ISO/ IEC 7816-4	Security architecture of CIPURSE™, built-in command set based on ISO 7816-4/-9, fully configurable file system based on ISO/ IEC 7816-4	Security architecture of CIPURSE™, built-in command set based on ISO 7816-4/-9, fully configurable file system based on ISO/ IEC 7816-4
Supported profiles	CIPURSE™L profile	CIPURSE™S profile	CIPURSE™T profile
Capabilities	1 CIPURSE™ application	Up to 8 CIPURSE™ applications configurable	Up to 8/16 CIPURSE™ applications configurable
EEPROM	304 Byte	1, 2, 4 kByte	8 kByte
Cryptography	AES 128-bit	AES 128-bit	AES 128-bit
Delivery forms	MCC8, NiAu-bump, sawn wafer	MCC8, NiAu-bump, sawn wafer	MCC8, NiAu-bump, sawn wafer
Tools	CIPURSE™ development kit	CIPURSE™ development kit	CIPURSE™ development kit
Typical applications	Public transport, ticketing, access management, micropayment	Public transport, ticketing, access management, micropayment	Public transport, ticketing, access management, micropayment
Certifications	CIPURSE™, NFC Forum Type 4 Tag	CC EAL5+ high, CIPURSE™, NFC Forum Type 4 Tag	CC EAL5+ high, CIPURSE™, NFC Forum Type 4 Tag

⁵⁾ Please note that xxx in product names stands for EEPROM size

	Contactless security controllers	Dual-interface security controllers		
Product name ³⁾	SLE 77CLFxxx1P(M)  SOLID FLASH™	SLE 77CLFxxxP(M)  SOLID FLASH™  Coil on Module new	SLC32TDzxxx  SOLID FLASH™  Coil on Module  Integrity Guard new	SLC36TDzxxx  SOLID FLASH™  Coil on Module new
Product description	Contactless security controller	Dual-interface security cryptocontroller for traditional transport use cases	Dual-interface security cryptocontroller for traditional transport use cases	Dual-interface security cryptocontroller for traditional transport use cases
Interfaces	ISO 14443 A/B, ISO 18092 passive mode, NRG™ (ISO/IEC 14443-3 type A with CRYPTO1)	ISO 7816, ISO 14443 A/B, ISO 18092 passive mode, optimized for small antenna sizes, optional NRG™ (ISO/IEC 14443-3 type A with CRYPTO1)	ISO 7816, ISO 14443 A/B, ISO 18092 passive mode, optimized for small antenna sizes, optional NRG™ (ISO/IEC 14443-3 type A with CRYPTO1)	ISO 7816 / I2C, ISO 14443 A/B, ISO 18092 passive mode, optimized for small antenna sizes, optional NRG™ (ISO/IEC 14443-3 type A with CRYPTO1)
NVM	60, 100 kByte	136, 156, 184, 200, 240 kByte	180, 212, 228, 268, 300, 348 kByte	352, 280 kByte
RAM	4 kByte	6 kByte	10 kByte	12 kByte
CPU	16-bit	16-bit	16-bit	32-bit Arm® SecurCore® SC300
Symmetrical cryptography	AES up to 256-bit, DES, 3DES	AES up to 256-bit, DES, 3DES	AES up to 256-bit, DES, 3DES	AES up to 256-bit, DES, 3DES
Asymmetrical cryptography		ECC up to 521-bit, RSA up to 4096-bit	ECC up to 521-bit, RSA up to 4096-bit	ECC up to 521-bit, RSA up to 4096-bit
Ambient temperature	-25°C to +85°C	-25°C to +85°C	-25°C to +85°C	-25°C to +85°C
Delivery forms	MCC8, NiAu-bump, sawn wafer	Coil on Module, MCC8, sawn wafer, 6/8 pin dual-interface modules and contactless modules	Coil on Module, MCC8, sawn wafer, 6/8 pin dual-interface modules and contactless modules	Coil on Module, sawn wafer, bumped wafer, 6/8 pin dual-interface modules and contactless modules
Typical applications	Public transport, ticketing	Public transport, ticketing	Public transport, ticketing	Public transport, ticketing
Certifications	CC EAL5+ high	CC EAL5+ high, CUP, EMVCo	CC EAL6+ high, CUP, EMVCo	CC EAL6+ high, EMVCo


³⁾ Please note that xxx in product names stands for NVM size, y – input capacity of derivatives, z – different interfaces



Transport Ticketing

	Contactless memory-based card and ticket products		
Product name	NRG™ SLE 66R35	SLE 66R01L	SLE 66R01P
			
Product description	(E7) = Supporting 7-byte UID, (I) = Supporting 4-byte fixed number, non-unique ID, (R) = Supporting 4-byte reused ID, Intelligent 1 kByte EEPROM	my-d™ move lean	my-d™ move
Interface	ISO/IEC 14443-3 Type A	ISO/IEC 14443-3 Type A, NFC Forum Type 2 Tag operation	ISO/IEC 14443-3 Type A, NFC Forum Type 2 Tag operation
Memory organization	16 fixed sectors	1 fixed sector	1 fixed sector
Counter	-	-	16-bit counter, anti-tearing support
EEPROM	768 Byte (user), 256 Byte (admin)	48 Byte (user), 16 Byte (admin)	128 Byte (user), 24 Byte (admin)
Security features	Mutual three-pass authentication with 48-bit keys, transport key	Block locking, individual page locking, unique serial number	32-bit password protection for read and/or write access, block locking, individual page locking, password retry counter, unique serial number
Distance (read/write)	Typically up to 10 cm and above	Typically up to 10 cm and above	Typically up to 10 cm and above
Data rate	106 kbit/s to card, 106 kbit/s to reader	106 kbit/s to card, 106 kbit/s to reader	106 kbit/s to card, 106 kbit/s to reader
Endurance	100000	10000	10000
Retention time, minimum	>10 years	>5 years	>5 years
Delivery forms	MCC2, MCC8, NiAu-bump, sawn wafer	NiAu-bump, sawn wafer	NiAu-bump, sawn wafer
Tools	Evaluation kit contactless	Evaluation kit contactless	Evaluation kit contactless
Typical applications	Transport ticketing, access management	Transport ticketing, access management	Transport ticketing, access management
Certifications	-	NFC Forum Type 2 Tag	NFC Forum Type 2 Tag




	CIPURSE™ components for terminals
Product name	CIPURSE™SAM (Secure Access Module) SLF 9630
Product description	CIPURSE™ secure access module with NRG™ (ISO/IEC 14443-3 type A with CRYPTO1) interface. Enables secured authentication between the reader and CIPURSE™ chip cards or cards using NRG™ (ISO/IEC 14443-3 type A with CRYPTO1) technology and AES128-based authentication schemes. It features a dedicated key management system including key derivation and key upload.
Interface	ISO 7816
Memory organization	Fully configurable, multi-application file system
Security features	3DES, AES128, AES192, AES256, CIPURSE™ and NRG™ (ISO/IEC 14443-3 type A with CRYPTO1) encryption, online and offline mode, secured key loading
Data rate	Subject to the active interface
Delivery forms	ID-1/ID-000 card (SIM format), VQFN-8
Tools	CIPURSE™ development kit
Typical applications	Access control, authentication, micropayment, transport ticketing
Certifications	CC EAL6+ high for HW, CIPURSE™

Authentication

Turnkey solutions				
Product name	OPTIGA™ TRUST B SLE 95250	OPTIGA™ TRUST E SLS 32AIA  SOLID FLASH™	OPTIGA™ Trust X SLS 32AIA	OPTIGA™ TRUST M SLS 32AIA
Product description	Product authentication and brand protection solution	Enhanced authentication solution for high-value goods	Enhanced device security solution	Enhanced device security solution
Interfaces	SWI	I2C	I2C	I2C (shielded connection)
EEPROM	512 bit	–	–	–
NVM	–	3 kByte	10 kByte	10 kByte
RAM	–	–	–	–
CPU	State machine	16-bit	16-bit	16-bit
Symmetrical cryptography	–	–	–	–
Asymmetrical cryptography	ECC 131-bit	ECC 256-bit	ECC 256-bit	ECC 256-bit, ECC 384-bit, RSA 1024-bit, RSA 2048-bit
Ambient temperature	-40°C to +85°C	-40°C to +85°C	SLS32AIA020X4 standard: -25 to +85°C SLS32AIA020X2 extended: -40 to +105°C	SLS32AIA010MS standard: -25 to +85°C ; SLS32AIA010MH extended: -40 to +105°C
Delivery forms	TSNP-6	USON-10-2	USON-10-2	USON-10
Typical applications	Authentication of consumer electronics, accessories, original replacement parts	PKI networks, consumer electronics, smart home, industrial automation, Internet of Things (IoT), authentication of system services and accessories, original replacement parts, smart metering, system configuration management, IP/software protection	Internet of Things (IoT), smart home, industrial automation, consumer electronics, smart metering, authentication of system services and accessories, original replacement parts, secure communication, IP/software protection	Mutual authentication, secured communication, secured updates, key provisioning, life-cycle management, data store protection, power management, platform integrity protection
Certifications	–	–	CC EAL 6+ (high) for the HW	CC EAL6+ (high) for HW

	Contact-based security controllers	
Product name	SLE 97C1FX1M00PE  SOLID FLASH™	SLE 97CSFX1M00PE  SOLID FLASH™
Product description	Security cryptocontroller	Security cryptocontroller
Interfaces	I2C, ISO 7816	ISO 7816, SPI
EEPROM	–	–
NVM	1 MByte	1 MByte
RAM	32 kByte	32 kByte
CPU	32-bit	32-bit
Symmetrical cryptography	AES up to 256-bit, DES, 3DES	AES up to 256-bit, DES, 3DES
Asymmetrical cryptography	ECC up to 521-bit, RSA up to 4096-bit	ECC up to 521-bit, RSA up to 4096-bit
Ambient temperature	-25°C to +85°C	-25°C to +85°C
Delivery forms	SMD, sawn wafer	SMD, sawn wafer
Typical applications	Authentication of system services, printers, system configuration management	Authentication of system services, printers, system configuration management
Certifications	CC EAL5+ high	CC EAL5+ high

Authentication

	Pay TV		
Product name	SLE 79CFXXX  SOLID FLASH™	SLC58VCAxxx  SOLID FLASH™ new	SLC58VCAxxxR8  SOLID FLASH™ new
Product description	Security controller	Security controller	Security controller
Interfaces	ISO 7816	ISO 7816, I2C	ISO 7816, I2C
EEPROM	-	-	-
NVM	up to 500 kByte	up to 352 kByte	up to 200 kByte
RAM	8 kByte	12 kByte	8 kByte
CPU	Dual 16-bit	Dual 16-bit	Dual 16-bit
Symmetrical cryptography	AES up to 256-bit, DES, 3DES	AES up to 256-bit, DES, 3DES	AES up to 256-bit, DES, 3DES
Asymmetrical cryptography	ECC up to 521-bit, RSA up to 4096-bit	ECC up to 521-bit, RSA up to 4096-bit	ECC up to 521-bit, RSA up to 4096-bit
Ambient temperature	-25°C to +85°C	-25°C to +85°C	-25°C to +85°C
Delivery forms	FCOS™ module, VQFN-8, sawn wafer, wire bond module	Sawn wafer, USON-10, wire bond module	Sawn wafer, USON-10, wire bond module
Typical applications	Conditional access	Conditional access	Conditional access
Certifications	CC EAL5+ high	CC EAL5+ high	CC EAL5+ high

³⁾ Please note that xxx in product names stands for NVM size



Trusted Computing

	OPTIGA™ TPM (Trusted Platform Module)			
Product name	OPTIGA™ TPM SLB 9645TT1.2	OPTIGA™ TPM SLB 9645XT1.2	OPTIGA™ TPM SLB 9645VQ1.2	OPTIGA™ TPM SLB 9645XQ1.2
Product description	The Infineon OPTIGA™ TPM (Trusted Platform Module) is a standardized security controller which provides a wide range of security functions for computing platforms and embedded systems.	The Infineon OPTIGA™ TPM (Trusted Platform Module) is a standardized security controller which provides a wide range of security functions for computing platforms and embedded systems.	The Infineon OPTIGA™ TPM (Trusted Platform Module) is a standardized security controller which provides a wide range of security functions for computing platforms and embedded systems.	The Infineon OPTIGA™ TPM (Trusted Platform Module) is a standardized security controller which provides a wide range of security functions for computing platforms and embedded systems.
Interfaces	I2C	I2C	I2C	I2C
Symmetrical cryptography	AES, HMAC, SHA-1	AES, HMAC, SHA-1	AES, HMAC, SHA-1	AES, HMAC, SHA-1
Asymmetrical cryptography	RSA1024, RSA2048	RSA1024, RSA2048	RSA1024, RSA2048	RSA1024, RSA2048
Ambient temperature	-20°C to +85°C	-40°C to +85°C	-20°C to +85°C	-40°C to +85°C
Package	TSSOP-28	TSSOP-28	VQFN-32	VQFN-32
Typical applications	PC and mobile computing on non-x86 platforms; embedded devices e.g. communication, gateways, printer, PoS systems, networking, ATMs	PC and mobile computing on non-x86 platforms; embedded devices e.g. communication, gateways, printer, PoS systems, networking, ATMs	PC and mobile computing on non-x86 platforms; embedded devices e.g. communication, gateways, printer, PoS systems, networking, ATMs	PC and mobile computing on non-x86 platforms; embedded Devices e.g. communication, gateways, printer, PoS systems, networking, ATMs
Certifications	based on CC EAL4+ certified HW	based on CC EAL4+ certified HW	based on CC EAL4+ certified HW	based on CC EAL4+ certified HW
Standard	Version 1.2 Rev. 116	Version 1.2 Rev. 116	Version 1.2 Rev. 116	Version 1.2 Rev. 116

OPTIGA™ TPM SLB 9660TT1.2	OPTIGA™ TPM SLB 9660XT1.2	OPTIGA™ TPM SLB 9660VQ1.2	OPTIGA™ TPM SLB 9660XQ1.2	OPTIGA™ TPM SLB 9665TT2.0
The Infineon OPTIGA™ TPM (Trusted Platform Module) is a standardized security controller which provides a wide range of security functions for computing platforms and embedded systems.	The Infineon OPTIGA™ TPM (Trusted Platform Module) is a standardized security controller which provides a wide range of security functions for computing platforms and embedded systems.	The Infineon OPTIGA™ TPM (Trusted Platform Module) is a standardized security controller which provides a wide range of security functions for computing platforms and embedded systems.	The Infineon OPTIGA™ TPM (Trusted Platform Module) is a standardized security controller which provides a wide range of security functions for computing platforms and embedded systems.	The Infineon OPTIGA™ TPM (Trusted Platform Module) is a standardized security controller which provides a wide range of security functions for computing platforms and embedded systems.
LPC	LPC	LPC	LPC	LPC
AES, HMAC, SHA-1	AES, HMAC, SHA-1	AES, HMAC, SHA-1	AES, HMAC, SHA-1	AES, HMAC, SHA-1, SHA-256
RSA1024, RSA2048	RSA1024, RSA2048	RSA1024, RSA2048	RSA1024, RSA2048	ECC, ECC BN-256, ECC NIST P-256, ECC256, ECDH, RSA1024, RSA2048
-20°C to +85°C	-40°C to +85°C	-20°C to +85°C	-40°C to +85°C	-20°C to +85°C
TSSOP-28	TSSOP-28	VQFN-32	VQFN-32	TSSOP-28
PC and mobile computing with Intel x86, ARM platforms and others; embedded devices e.g. communication, gateways, printer, PoS systems, networking, ATMs	PC and mobile computing with Intel x86, ARM platforms and others; embedded devices e.g. communication, gateways, printer, PoS systems, networking, ATMs	PC and mobile computing with Intel x86, ARM platforms and others; embedded devices e.g. communication, gateways, printer, PoS systems, networking, ATMs	PC and mobile computing with Intel x86, ARM platforms and others; embedded devices e.g. communication, gateways, printer, PoS systems, networking, ATMs	PC and mobile computing with Intel x86, ARM platforms and others; embedded devices e.g. communication, gateways, printer, PoS systems, networking, ATMs
CC EAL4+, FIPS 140-2 level 2 (with FW update)	CC EAL4+, FIPS 140-2 level 2 (with FW update)	CC EAL4+, FIPS 140-2 level 2 (with FW update)	CC EAL4+, FIPS 140-2 level 2 (with FW update)	CC EAL4+, FIPS 140-2 level 2 (with FW update)
Version 1.2 Rev. 116	Version 1.2 Rev. 116	Version 1.2 Rev. 116	Version 1.2 Rev. 116	Version 2.0 Rev. 01.16

Trusted Computing

	OPTIGA™ TPM (Trusted Platform Module)			
Product name	OPTIGA™ TPM SLB 9665XT2.0	OPTIGA™ TPM SLB 9665VQ2.0	OPTIGA™ TPM SLB 9665XQ2.0	OPTIGA™ TPM SLB 9670VQ1.2
Product description	The Infineon OPTIGA™ TPM (Trusted Platform Module) is a standardized security controller which provides a wide range of security functions for computing platforms and embedded systems.	The Infineon OPTIGA™ TPM (Trusted Platform Module) is a standardized security controller which provides a wide range of security functions for computing platforms and embedded systems.	The Infineon OPTIGA™ TPM (Trusted Platform Module) is a standardized security controller which provides a wide range of security functions for computing platforms and embedded systems.	The Infineon OPTIGA™ TPM (Trusted Platform Module) is a standardized security controller which provides a wide range of security functions for computing platforms and embedded systems.
Interfaces	LPC	LPC	LPC	SPI
Symmetrical cryptography	AES, HMAC, SHA-1, SHA-256	AES, HMAC, SHA-1, SHA-256	AES, HMAC, SHA-1, SHA-256	AES, HMAC, SHA-1
Asymmetrical cryptography	ECC, ECC BN-256, ECC NIST P-256, ECC256, ECDH, RSA1024, RSA2048	ECC, ECC BN-256, ECC NIST P-256, ECC256, ECDH, RSA1024, RSA2048	ECC, ECC BN-256, ECC NIST P-256, ECC256, ECDH, RSA1024, RSA2048	RSA1024, RSA2048
Ambient temperature	-40°C to +85°C	-20°C to +85°C	-40°C to +85°C	-20°C to +85°C
Package	TSSOP-28	VQFN-32	VQFN-32	VQFN-32
Typical applications	PC and mobile computing with Intel x86, ARM platforms and others; embedded devices e.g. communication, gateways, printer, PoS systems, networking, ATMs	PC and mobile computing with Intel x86, ARM platforms and others; embedded devices e.g. communication, gateways, printer, PoS systems, networking, ATMs	PC and mobile computing with Intel x86, ARM platforms and others; embedded devices e.g. communication, gateways, printer, PoS systems, networking, ATMs	PC and mobile computing with Intel x86, ARM platforms and others; embedded devices e.g. communication, gateways, printer, PoS systems, networking, ATMs
Certifications	CC EAL4+, FIPS 140-2 level 2 (with FW update)	CC EAL4+, FIPS 140-2 level 2 (with FW update)	CC EAL4+, FIPS 140-2 level 2 (with FW update)	CC EAL4+, FIPS 140-2 level 2 (with FW update)
Standard	Version 2.0 Rev. 01.16	Version 2.0 Rev. 01.16	Version 2.0 Rev. 01.16	Version 1.2 Rev. 116
Qualification	-	-	-	-

		OPTIGA™ TPM Industrial	OPTIGA™ TPM Automotive
OPTIGA™ TPM SLB 9670XQ1.2	OPTIGA™ TPM SLB 9670VQ2.0	OPTIGA™ TPM SLM 9670	OPTIGA™ TPM SLI 9670
The Infineon OPTIGA™ TPM (Trusted Platform Module) is a standardized security controller which provides a wide range of security functions for computing platforms and embedded systems.	The Infineon OPTIGA™ TPM (Trusted Platform Module) is a standardized security controller which provides a wide range of security functions for computing platforms and embedded systems.	The Infineon OPTIGA™ TPM (Trusted Platform Module) SLM 9670 is a special model of OPTIGA™ TPM that meets the requirements of industrial and other demanding applications, where key requirements include an extended temperature range (-40 to +105°C), extended lifetime, long-lasting supply availability in combination with industrial quality grade.	The Infineon OPTIGA™ TPM is a standardized security controller which provides a wide range of security functions for automotive use cases. SLI9670 is AEC-Q100 qualified and does meet automotive requirements for robustness.
SPI	SPI	SPI	SPI
AES, HMAC, SHA-1	AES, HMAC, SHA-1, SHA-256	HMAC, SHA-1, SHA-256	HMAC, SHA-1, SHA-256
RSA1024, RSA2048	ECC, ECC BN-256, ECC NIST P-256, ECC256, ECDH, RSA1024, RSA2048	ECC, ECC BN-256, ECC NIST P-256, ECC256, ECDH, RSA1024, RSA2048	ECC, ECC BN-256, ECC NIST P-256, ECC256, ECDH, RSA1024, RSA2048
-40°C to +85°C	-20°C to +85°C	-40°C to +105°C	-40°C to +105°C
VQFN-32	VQFN-32	VQFN-32	VQFN-32
PC and mobile computing with Intel x86, ARM platforms and others; embedded devices e.g. communication, gateways, printer, PoS systems, networking, ATMs	PC and mobile computing with Intel x86, ARM platforms and others; embedded devices e.g. communication, gateways, printer, PoS systems, networking, ATMs	Industrial computing, industrial PCs, servers, tablets, single-board computers, programmable logic controllers (PLCs), industrial networking infrastructure & equipment, industrial servers, gateways, routers, switches	Enhance security in critical automotive applications such as gateway, telematics or multimedia headunits with tamper resist & secure key-storage, -generation & -management and authentication
CC EAL4+, FIPS 140-2 level 2 (with FW update)	CC EAL4+ & FIPS 140-2 level 2 combined certification	CC EAL4+, FIPS 140-2	CC EAL4+, FIPS 140-2
Version 1.2 Rev. 116	Version 2.0 Rev. 01.38	Version 2.0 Rev. 1.38	Version 2.0 Rev. 1.38
-	-	-	AEC-Q100

Object Identification

	my-d™ vicinity plain			
Product name	SRF 55V02P 	SRF 55V02P HC 	SRF 55V10P 	SRF 55V10P HC 
Product description	my-d™ vicinity Plain mode with open memory access, NFC Forum Type 5 Tag certified	my-d™ vicinity, 97pF high capacitance Plain mode with open memory access, NFC Forum Type 5 Tag certified	my-d™ vicinity Plain mode with open memory access, NFC Forum Type 5 Tag certified	my-d™ vicinity, 97pF high capacitance Plain mode with open memory access, NFC Forum Type 5 Tag certified
Interface	ISO/IEC 15693, ISO/IEC 18000-3 mode 1	ISO/IEC 15693, ISO/IEC 18000-3 mode 1	ISO/IEC 15693, ISO/IEC 18000-3 mode 1	ISO/IEC 15693, ISO/IEC 18000-3 mode 1
Memory organization	1 fixed sector	1 fixed sector	1 fixed sector	1 fixed sector
Counter	Anti-tearing support, up to 65, 536 units	Anti-tearing support, up to 65, 536 units	Anti-tearing support, up to 65, 536 units	Anti-tearing support, up to 65, 536 units
EEPROM	232 Byte (user), 64 Byte (admin)	232 Byte (user), 64 Byte (admin)	1000 Byte (user), 256 Byte (admin)	1000 Byte (user), 256 Byte (admin)
Security features	Individual page locking, unique serial number	Individual page locking, unique serial number	Individual page locking, unique serial number	Individual page locking, unique serial number
Distance (read/write)	Typically up to 1.5 m	Typically up to 1.5 m	Typically up to 1.5 m	Typically up to 1.5 m
Data rate	26.48 kbit/s	26.48 kbit/s	26.48 kbit/s	26.48 kbit/s
Endurance	100000	100000	100000	100000
Retention time, minimum	>10 years	>10 years	>10 years	>10 years
Delivery forms	MCC2, MCC8, NiAu-bump, sawn wafer	MCC2, MCC8, NiAu-bump, sawn wafer	MCC2, MCC8, NiAu-bump, sawn wafer	MCC2, MCC8, NiAu-bump, sawn wafer
Tools	Evaluation kit contactless	Evaluation kit contactless	Evaluation kit contactless	Evaluation kit contactless
Typical applications	Supply chain management, library management, health-care, pharmaceutical, product authentication, amusement ticketing	Laundry automation, supply chain management, library management, health-care, pharmaceutical, product authentication amusement ticketing	Supply chain management, library management, health-care, pharmaceutical, product authentication, amusement ticketing	Supply chain management, library management, health-care, pharmaceutical, product authentication, amusement ticketing
Certifications	NFC Forum Type 5 Tag	NFC Forum Type 5 Tag	NFC Forum Type 5 Tag	NFC Forum Type 5 Tag

my-d™ vicinity secure			
SRF 55V02S	SRF 55V02S HC	SRF 55V10S	SRF 55V10S HC
my-d™ vicinity secure Security memory with security logic for memory access controlled by authentication procedures	my-d™ vicinity secure Security memory with security logic for memory access controlled by authentication procedures. 97pF high capacitance	my-d™ vicinity secure Security memory with security logic for memory access controlled by authentication procedures	my-d™ vicinity secure Security memory with security logic for memory access controlled by authentication procedures. 97pF high capacitance
ISO/IEC 15693, ISO/IEC 18000-3 mode 1	ISO/IEC 15693, ISO/IEC 18000-3 mode 1	ISO/IEC 15693, ISO/IEC 18000-3 mode 1	ISO/IEC 15693, ISO/IEC 18000-3 mode 1
Fully configurable, up to 15 sectors (14 secure, 1 plain)	Fully configurable, up to 15 sectors (14 secure, 1 plain)	Fully configurable, up to 15 sectors (14 secure, 1 plain)	Fully configurable, up to 15 sectors (14 secure, 1 plain)
Anti-tearing support, up to 65, 536 units	Anti-tearing support, up to 65, 536 units	Anti-tearing support, up to 65, 536 units	Anti-tearing support, up to 65, 536 units
224 Byte (user), 64 Byte (admin)	224 Byte (user), 64 Byte (admin)	992 Byte (user), 256 Byte (admin)	992 Byte (user), 256 Byte (admin)
2-way mutual authentication with 64-bit secret key between reader and card for basic security. 64-bit keys for each sector enable hierarchical key management multi-application functionality transport key, unique serial number	2-way mutual authentication with 64-bit secret key between reader and card for basic security. 64-bit keys for each sector enable hierarchical key management multi-application functionality transport key, unique serial number	2-way mutual authentication with 64-bit secret key between reader and card for basic security. 64-bit keys for each sector enable hierarchical key management multi-application functionality transport key, unique serial number	2-way mutual authentication with 64-bit secret key between reader and card for basic security. 64-bit keys for each sector enable hierarchical key management multi-application functionality transport key, unique serial number
Typically up to 1.5 m	Typically up to 1.5 m	Typically up to 1.5 m	Typically up to 1.5 m
26.48 kbit/s	26.48 kbit/s	26.48 kbit/s	26.48 kbit/s
100000	100000	100000	100000
>10 years	>10 years	>10 years	>10 years
MCC2, MCC8, NiAu-bump, sawn wafer	MCC2, MCC8, NiAu-bump, sawn wafer	MCC2, MCC8, NiAu-bump, sawn wafer	MCC2, MCC8, NiAu-bump, sawn wafer
Evaluation kit contactless	Evaluation kit contactless	Evaluation kit contactless	Evaluation kit contactless
Supply chain management, library management, health-care, pharmaceutical, product authentication, amusement ticketing, access control	Supply chain management, library management, health-care, pharmaceutical, product authentication, amusement ticketing, access control	Supply chain management, library management, health-care, pharmaceutical, product authentication, amusement ticketing, access control	Inventory control, library management, health-care, pharmaceutical, product authentication, amusement ticketing, access control

Object Identification

	my-d™ NFC			
Product name	SLE 66R08P new	SLE 66R16P new	SLE 66R32P new	SLE 66R64P new
Product description	my-d™ NFC, plain mode with open memory access	my-d™ NFC, plain mode with open memory access, support of NFC Forum Type 2 Tag Operation	my-d™ NFC, plain mode with open memory access , support of NFC Forum Type 2 Tag Operation	my-d™ NFC, plain mode with open memory access, support of NFC Forum Type 2 Tag Operation
Interface	ISO/IEC 14443 Type A	ISO/IEC 14443 Type A	ISO/IEC 14443 Type A	ISO/IEC 14443 Type A
Memory organization	1 fixed sector	1 fixed sector , nFC Forum Type 2 Tag up to 1024 Byte	1 fixed sector, NFC Forum Type 2 Tag up to 2048 Byte	1 fixed sector, NFC Forum Type 2 Tag up to 4096 Byte
Counter	Anti-tearing support, up to 65, 536 units	Anti-tearing support, up to 65, 536 units	Anti-tearing support, up to 65, 536 units	Anti-tearing support, up to 65, 536 units
EEPROM	1000 Byte (user), 280 Byte (admin)	2024 Byte (user), 536 Byte (admin)	4072 Byte (user), 1048 Byte (admin)	8168 Byte (user), 2072 Byte (admin)
Security features	Individual page locking, unique serial number	Individual page locking, unique serial number	Individual page locking, unique serial number	Individual page locking, unique serial number
Distance (read/write)	Typically up to 10 cm and above	Typically up to 10 cm and above	Typically up to 10 cm and above	Typically up to 10 cm and above
Data rate	106 kbit/s to card, 848 kbit/s to reader	106 kbit/s to card, 848 kbit/s to reader	106 kbit/s to card, 848 kbit/s to reader	106 kbit/s to card, 848 kbit/s to reader
Endurance	100000	100000	100000	100000
Retention time, minimum	>10 years	>10 years	>10 years	>10 years
Delivery forms	MCC2, MCC8, NiAu-bump, sawn wafer	MCC2, MCC8, NiAu-bump, sawn wafer	MCC2, MCC8, NiAu-bump, sawn wafer	MCC2, MCC8, NiAu-bump, sawn wafer
Tools	Evaluation kit contactless	Evaluation kit contactless	Evaluation kit contactless	Evaluation kit contactless
Typical applications	NFC Device pairing, smart posters, consumer goods information, data logging	NFC Device pairing, smart posters, consumer goods information, data logging	NFC Device pairing, smart posters, consumer goods information, data logging	NFC Device pairing, smart posters, consumer goods information, data logging


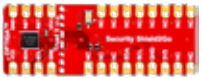
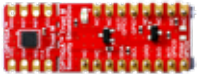

my-d™ proximity 2			
SLE 66R08S new	SLE 66R16S new	SLE 66R32S new	SLE 66R64S new
my-d™ proximity 2, security memory with security logic for memory access controlled by authentication procedures	my-d™ proximity 2, security memory with security logic for memory access controlled by authentication procedures	my-d™ proximity 2, security memory with security logic for memory access controlled by authentication procedures	my-d™ proximity 2, security memory with security logic for memory access controlled by authentication procedures
ISO/IEC 14443 Type A	ISO/IEC 14443 Type A	ISO/IEC 14443 Type A	ISO/IEC 14443 Type A
Fully configurable, up to 15 sectors (14 secure, 1 plain)	Fully configurable, up to 15 sectors (14 secure, 1 plain)	Fully configurable, up to 15 sectors (14 secure, 1 plain)	Fully configurable, up to 15 sectors (14 secure, 1 plain)
Anti-tearing support, up to 65, 536 units	Anti-tearing support, up to 65, 536 units	Anti-tearing support, up to 65, 536 units	Anti-tearing support, up to 65, 536 units
984 Byte (user), 296 Byte (admin)	2008 Byte (user), 552 Byte (admin)	4056 Byte (user), 1064 Byte (admin)	8152 Byte (user), 2088 Byte (admin)
2-way mutual authentication with 64-bit secret key between reader and card for basic security. 64-bit keys for each sector enable hierarchical key management, multi-application, functionality transport key, unique serial number	2-way mutual authentication with 64-bit secret key between reader and card for basic security. 64-bit keys for each sector enable hierarchical key management, multi-application, functionality transport key, unique serial number	2-way mutual authentication with 64-bit secret key between reader and card for basic security. 64-bit keys for each sector enable hierarchical key management, multi-application, functionality transport key, unique serial number	2-way mutual authentication with 64-bit secret key between reader and card for basic security. 64-bit keys for each sector enable hierarchical key management, multi-application, functionality transport key, unique serial number
Typically up to 10 cm and above	Typically up to 10 cm and above	Typically up to 10 cm and above	Typically up to 10 cm and above
106 kbit/s to card, 848 kbit/s to reader	106 kbit/s to card, 848 kbit/s to reader	106 kbit/s to card, 848 kbit/s to reader	106 kbit/s to card, 848 kbit/s to reader
100000	100000	100000	100000
>10 years	>10 years	>10 years	>10 years
MCC2, MCC8, NiAu-bump, sawn wafer	MCC2, MCC8, NiAu-bump, sawn wafer	MCC2, MCC8, NiAu-bump, sawn wafer	MCC2, MCC8, NiAu-bump, sawn wafer
Evaluation kit contactless	Evaluation kit contactless	Evaluation kit contactless	Evaluation kit contactless
Ticketing, consumer goods information, data logging, product authentication, access control	Ticketing, consumer goods information, data logging, product authentication, access control	Ticketing, consumer goods information, data logging, product authentication, access control	Ticketing, consumer goods information, data logging, product authentication, access control






Object Identification

	my-d™ components for terminals
Product name	EasySAM (Secure Access Module) SLF 9620
Product description	Secure access module for NRG™ (ISO/IEC 14443-3 type A with CRYPTO1), interface, my-d™ algorithm, 3DES and AES128. Enables secured authentication between the reader and my-d™ chip cards or cards using NRG™(TM) (ISO/IEC 14443-3 type A with CRYPTO1) technology.
Interface	ISO 7816-3 T=1
Memory organization	Fixed pre-defined file system
Security features	NRG™ (ISO/IEC 14443-3 type A with CRYPTO1) encryption, my-d™ encryption schemes, 3DES and AES128, online and offline modes, secured key loading
Data rate	Subject to the active interface
Delivery forms	ID-1/ID-000 card (SIM format), VQFN-8
Tools	Evaluation kit contactless
Typical applications	Security applications with key-based authentication, transport ticketing, access management
Certifications	CC EAL5+ high for HW











Evaluation Boards

	OPTIGA™ Trust Shield2Go			
Product name	S2Go Security OPTIGA™ Trust E	S2Go Security OPTIGA™ Trust X	S2Go Security OPTIGA™ Trust M <small>new</small>	MY IOT ADAPTER
Picture				
Product description	This Shield2Go board is equipped with one OPTIGA™ Trust E security chip and comes with a ready-to-use Arduino library. By combining Shield2Go boards with Infineon MyIoT adapters, customized system solutions can be developed.	This Shield2Go board is equipped with one OPTIGA™ Trust X security chip and comes with a ready-to-use Arduino library. By combining Shield2Go boards with Infineon MyIoT adapters, customized system solutions can be developed.	This Shield2Go board is equipped with one OPTIGA™ Trust M security chip and comes with a ready-to-use Arduino library. By combining Shield2Go boards with Infineon MyIoT adapters, customized system solutions can be developed.	By combining Shield2Go boards with the Infineon My IoT adapter, customized system solutions can be developed and evaluated.
Configuration	-	-	-	Infineon Shield2Go boards
Typical applications	Device authentication, embedded systems networked over the IoT, industrial control and automation, medical devices, consumer electronics, smart home, PKI networks	Embedded systems networked over the IoT, industrial control and automation, medical devices, consumer electronics, smart home, PKI networks	Embedded systems networked over the IoT, industrial control and automation, medical devices, consumer electronics, smart home, PKI networks	Device authentication, embedded systems networked over the IoT, industrial control and automation, medical devices, consumer electronics, smart home, PKI networks
Qualification	Consumer, industrial	Consumer, industrial	Consumer, industrial	Consumer, industrial
Input type	DC	DC	DC	DC
Supply voltage min	3.13 V	3.13 V	3.13 V	3.15 V
Supply voltage max	3.63 V	3.63 V	3.63 V	5 V
Supply voltage	-	-	-	-

OPTIGA™ Trust Evaluation Kits				OPTIGA™ TPM MCU board
OPTIGA™ Trust B EVAL KIT	OPTIGA™ Trust X EVAL KIT	OPTIGA™ Trust E EVAL KIT	OPTIGA™ Trust M EVAL KIT new	A-TPM BOARD SLI 9670 new
				
The OPTIGA™ Trust B SLE95250 evaluation and demonstration kit is an easy way of getting started with counterfeit protection. It can be used to demonstrate an authentication flow and to check how to read and write on the storage. The software GUI can be downloaded from the Infineon portal myICP for installation on a PC.	With the XMC4500 controller as the host on the evaluation kit allows users to connect to the OPTIGA™ Trust X (SLS 32AIA) through the I2C interface. Customers can use this evaluation kit to either debug the host lib code or demonstrate major features of the OPTIGA™ Trust X through an intuitive PC GUI.	With the XMC4500 controller as the host on the evaluation kit allows users to connect to the OPTIGA™ Trust E (SLS 32AIA) through the I2C interface. Customers can use this evaluation kit to either debug the host lib code or demonstrate major features of the OPTIGA™ Trust E through an intuitive PC GUI.	With the XMC4800 controller as the host on the evaluation kit allows users to connect to the OPTIGA™ Trust M (SLS 32AIA) through the I2C interface. Customers can use this evaluation kit to either debug the host lib code or demonstrate major features of the OPTIGA™ Trust M.	Infineon A-TPM BOARD is featuring the automotive qualified TPM SLI 9670. It is an add-on board for the Infineon AURIX™ TC3 host, supported by TPM Software Stack (TSS).
SLE95250 for XMC4500	–	–	–	SLI 9670 TPM 2.0 for AURIX™ TriBoard TC389 EVB
Battery authentication, IoT edge devices, consumer accessories, IP	Device authentication, embedded systems networked over the IoT, industrial control and automation, medical devices, consumer electronics, smart home,	Device authentication, embedded systems networked over the IoT, industrial control and automation, medical devices, consumer electronics, smart home, PKI networks	Device authentication, embedded systems networked over the IoT, industrial control and automation, medical devices, consumer electronics, smart home	Automotive security
Consumer, industrial	Consumer, industrial	Consumer, industrial	Consumer, industrial	Automotive (AEC-Q100)
DC	DC	DC	DC	DC
4.2 V	3.13 V	3.13 V	3.13 V	1.65 V
5 V	3.63 V	3.63 V	3.63 V	3.6 V
4.4 V	3.3 V	3.3 V	3.3 V	3.3 V






Evaluation Boards

	OPTIGA™ TPM Iridiumboards			
Product name	TPM SLB 9645 IRIDIUMBOARD	IRIDIUM9670 TPM1.2 LINUX	IRIDIUM9670 TPM2.0 LINUX	IRIDIUM SLI9670 TPM2.0 LINUX
Picture				
Product description	Infineon TPM SLB 9645 Iridium add-on board for Raspberry Pi and BeagleBoard xM. For integration into the corresponding platform OS (Linux, Win 10 IoT, etc.).	Infineon TPM SLB 9670 Iridium add-on board for Raspberry Pi. For integration into the corresponding platform OS (Linux, Win 10 IoT, etc.).	Infineon TPM SLB 9670 Iridium add-on board for Raspberry Pi. For integration into the corresponding platform OS (Linux, Win 10 IoT, etc.).	Infineon TPM SLI 9670 Iridium add-on board for Raspberry Pi. For integration into the corresponding platform OS (Linux etc.).
Configuration	SLB 9645 TPM 1.2 for Raspberry Pi	SLB 9670 TPM 1.2 for Raspberry Pi	SLB 9670 TPM 2.0 for Raspberry Pi	SLI 9670 TPM 2.0 for Raspberry Pi
Typical applications	Embedded computing, trusted computing	Embedded computing, trusted computing	Embedded computing, trusted computing	Automotive security
Qualification	Consumer, industrial	Consumer, industrial	Consumer, industrial	Automotive (AEC-Q100)
Input type	DC	DC	DC	DC
Supply voltage min	1.65 V	1.65 V	1.65 V	1.65 V
Supply voltage max	3.6 V	3.6 V	3.6 V	3.6 V
Supply voltage	3.3 V	3.3 V	3.3 V	3.3 V









	OPTIGA™ TPM Xenonboards		
IRIDIUM SLM9670 TPM2.0 LINUX	TPM 70 1.2 XENONBOARD	TPM 65 XENONBOARD	TPM 70 2.0 XENONBOARD
			
Infineon TPM SLM 9670 Iridium add-on board for Raspberry Pi. For integration into the corresponding platform OS (Linux, Win 10 IoT, etc.).	Infineon TPM SLB 9670 Xenon is an add-on board for the PC platform. For integration into the corresponding platform OS (Windows, Linux, Win 10 IoT, etc.).	Infineon TPM SLB 9665 Xenon is an add-on board for a PC platform. For integration into the corresponding platform OS (Windows, Linux, Win 10 IoT, etc.).	Infineon TPM SLB 9670 Xenon is an add-on board for the PC platform. For integration into the corresponding platform OS (Windows, Linux, Win 10 IoT, etc.).
SLM 9670 TPM 2.0 for Raspberry Pi	SLB 9670 TPM 1.2 for a PC platform	SLB 9665 TPM 2.0 for a PC platform	SLB 9670 TPM 2.0 for a PC platform
Industrial computing, industrial PCs, servers, tablets, single-board computers, Programmable Logic Controllers (PLCs), industrial networking infrastructure & equipment, industrial servers, gateways, routers, switches	Embedded computing, trusted computing	Embedded computing, trusted computing	Embedded computing, trusted computing
-	-	-	-
DC	DC	DC	DC
1.65 V	1.65 V	3 V	1.65 V
3.6 V	3.6 V	3.6 V	3.6 V
3.3 V	3.3 V	3.3 V	3.3 V






Modules

	Contactless controller & memory modules			Contact-based controller modules
Product name	P-MCS8-2-1	P-MCC8-2-6	P-MCC2-2-1	S-MID4.8
Picture				
Product description	Thin contactless module, mold	Standard contactless module, mold	Contactless module, mold	Contact-based module for highly demanding applications
Pitch	9.5 mm	9.5 mm	4.75 mm	14.25 mm
Dimensions	8.1 x 5.15 mm	8.1 x 5.15 mm	10.3 x 2.9 mm	13 x 11.8 mm
Thickness	max. 250 µm	max. 340 µm	max. 330 µm	max. 420 µm
Contact surface	Ag	Ag	Ag	NiAu
ISO reference	ISO 7816-1, ISO 10373-1/-3, ISO 7810, ISO 14443	ISO 7816-1, ISO 10373-1/-3, ISO 7810, ISO 14443	ISO 7816-1, ISO 10373-1/-3, ISO 7810, ISO 14443	ISO 7816-1, ISO 10373-1/-3, ISO 7810
Derivatives	-	-	-	Au surface, Pd surface
Delivery form	Tape on Reel	Tape on Reel	Tape on Reel	Tape on Reel
Main applications	Payment, government identification	Payment, government identification, transport ticketing	Access control, transport ticketing	Authentication, government identification

S-MFC6.8	S-MFC6.6	P-M2M4.7	P-M4.8	T-M4.8
				
Contact-based module, 8 contacts	Contact-based module, 6 contacts	Contact-based module, 8 contacts, epoxy tape, mold, wire bond	Contact-based module, 8 contacts, epoxy tape, mold, wire bond	Contact-based module, 8 contacts, epoxy tape, wire bond globe top
14.25 mm	9.5 mm	14.25 mm	14.25 mm	14.25 mm
13 x 11.8 mm	11 x 8.3 mm	12.8 x 10.8 mm	13 x 11.8 mm	13 x 11.8 mm
max. 420 µm	max. 420 µm	max. 600 µm	max. 600 µm	max. 580 µm
NiAu	NiAu	NiAu	NiAu	NiAu
ISO 7816-1, ISO 10373-1/-3, ISO 7810	ISO 7816-1, ISO 10373-1/-3, ISO 7810	ISO 7816-1, ISO 10373-1/-3, ISO 7810	ISO 7816-1, ISO 10373-1/-3, ISO 7810	ISO 7816-1, ISO 10373-1/-3, ISO 7810
Au surface, Pd surface	Au surface, Pd surface	Au surface	Au surface, Pd surface	Au surface, Pd surface
Tape on Reel	Tape on Reel	Tape on Reel	Tape on Reel	Tape on Reel
Payment, government identification	Payment, government identification	M2M	Payment, government identification	Payment, government identification, Pay TV

Modules

Dual-interface modules				
Product name	S-COM10.6  Coil on Module	S-COM8.6  Coil on Module	S-COM8.4  Coil on Module	S-COMCL1-0-1  Coil on Module
Picture				
Product description	Dual-interface module with inductive coupling for highly demanding applications	Dual-interface module, 6 CB contacts, inductive coupling	Dual-interface module, 6 CB contacts, inductive coupling	Ultra-thin contactless module, with inductive coupling
Pitch	14.25 mm	14.25 mm	9.5 mm	9.5 mm
Dimensions	13 x 11.8 mm	13 x 11.8 mm	11 x 8.3 mm	8 x 8 mm
Thickness	max. 420 µm	max. 420 µm	max. 320 µm	max. 125 µm
Contact surface	NiAu	NiAu	NiAu	Inductive coupling
ISO reference	ISO 7816-1, ISO 10373-1/-3, ISO 7810, ISO 14443	ISO 7816-1, ISO 10373-1/-3, ISO 7810, ISO 14443	ISO 7816-1, ISO 10373-1/-3, ISO 7810, ISO 14443	ISO 7816-1, ISO 10373-1/-3, ISO 7810, ISO 14443
Derivatives	Au surface, Pd surface	Au surface, Pd surface	Au surface, Pd surface	-
Delivery form	Tape on Reel	Tape on Reel	Tape on Reel	Tape on Reel
Main applications	Authentication, government identification, payment	Payment, government identification	Payment, government identification	Government identification

T-M8.8	P-M8.4	T-M8.6	S-SPA1.x	S-COM10.8 new
				
Standard dual-interface module, 2 antenna contacts, 8 CB contacts	Dual-interface module, mold, 2 antenna contacts, 8 CB contacts, epoxy tape, wire bond	Standard dual-interface module, 2 antenna contacts, 6 CB contacts	Smart Payment Accessory - the ready-to-use solution for wearables and stickers	Dual-interface module with inductive coupling for highly demanding applications
14.25 mm	14.25 mm	9.25 mm	19.00 mm	14.25 mm
13 x 11.8 mm	13 x 11.8 mm	11 x 8.3 mm	27.2 x 17.5 mm	13 x 11.8 mm
max. 580 µm	max. 620 µm	max. 580 µm	max. 300 µm	max. 420 µm
NiAu	NiAu	NiAu	n.a.	NiAu
ISO 7816-1, ISO 10373-1/-3, ISO 7810, ISO 14443	ISO 7816-1, ISO 10373-1/-3, ISO 7810, ISO 14443	ISO 7816-1, ISO 10373-1/-3, ISO 7810, ISO 14443	EMVCo	ISO 7816-1, ISO 10373-1/-3, ISO 7810, ISO 14443
Au surface, Pd surface	Au surface, Pd surface	Au surface, Pd surface	n.a.	Au surface, Pd surface
Tape on Reel	Tape on Reel	Tape on Reel	Tape on Reel	Tape on Reel
Payment, government identification	Payment, government identification	Payment, government identification	Payment	Authentication, government identification

SMD

SMD packages				
Product name	TSNP-6-9	TSSOP-28-2	VQFN-8-1, -2, -4, -6/MFF2	VQFN-10-2
Picture				
Product description	Thin Small Non-leaded Package	Thin shrink small outline, gull-wing lead	Small outline no leads, exposed pad	Small outline no leads, exposed pads
Pitch	0.5 mm	0.65 mm	1.27 mm	1.27 mm
Dimensions	1.1 x 1.5 mm	9.7 x 4.4 mm	5 x 6 mm	6 x 5 mm
Thickness	0.375 mm	max. 1.1 mm	max. 900 µm	max. 900 µm
Contact surface	Sn	Sn	NiPd-AuAg	NiPd-AuAg
ISO reference	-	-	-	-
Derivatives	-	-	-	-
Delivery form	Tape & Reel	Tape & Reel	Tape & Reel	Tape & Reel
Main applications	Authentication	Trusted Computing	Automotive M2M, industrial M2M, consumer M2M, authentication	Authentication, Pay TV

VQFN-32-13, -20	USON-8-1, -4	USON-8-3	USON-10-1	USON-10-2, -4
				
Quad flat no leads, exposed pad	Small outline no leads, exposed bar pad	Small outline no-leads, exposed pad	Small outline no leads, exposed bar pad	Small outline no leads, exposed pad
0.5 mm	0.5 mm	1.0 mm	0.5 mm	0.5 mm
5 x 5 mm	2.5 x 2.5 mm	4.2 x 4.0 mm	3 x 3 mm	3 x 3 mm
max. 900 µm	max. 600 µm	max. 600 µm	max. 600 µm	max. 600 µm
NiPd-AuAg	NiPd-AuAg	NiPd-AuAg	NiPd-AuAg	NiPd-AuAg
-	-	-	-	-
-	-	-	-	-
Tape & Reel	Tape & Reel	Tape & Reel	Tape & Reel	Tape & Reel
Embedded secure element, Trusted Computing, USB tokens	Authentication	Authentication	Authentication	Authentication

SMD




	SMD packages			
Product name	X2QFN-24-1 new	USON-8-5 new	USON-8-6 new	USON-6-2 new
Picture				
Product description	Small outline no leads, exposed pad	Small outline no leads, exposed pad	Small outline no leads, exposed pad	Small outline no leads, exposed pad
Pitch	0.5 mm	0.5 mm	0.5 mm	0.5 mm
Dimensions	4 x 4 mm	2 x 2 mm	2 x 2 mm	3 x 2.3 mm
Thickness	max. 330 µm	max. 600 µm	max. 600 µm	max. 600 µm
Contact surface	NiPd-AuAg	NiPd-AuAg	NiPd-AuAg	NiPd-AuAg
ISO reference	-	-	-	-
Derivatives	-	-	-	-
Delivery form	Tape & Reel	Tape & Reel	Tape & Reel	Tape & Reel
Main applications	-	-	-	-

TSNP-6-12 new	VQFN-32-19 new from April 2021
	
Thin Small Non-leaded Package	Small outline no leads, exposed pad
0.5 mm	0.4 mm
1,5 x 1,5 mm	4 x 4 mm
max. 400 µm	max. 900 µm
Sn	NiPd-AuAg
-	-
-	-
Tape & Reel	Tape & Reel
-	-

SMD

SMD packages	
Product name	SG-WFWLB-16-3 new SG-XFWLB-25-3 new SG-XFWLB-6-2 new SG-XFWLB-6-3 new
Picture	   
Product description	Chip scale package, solder ball array Chip scale package, solder ball array Chip scale package, solder ball array Chip scale package, solder ball array
Pitch	0.5 mm 0.4mm 0.4mm 0.4mm
Dimensions	2.72 x 2.55 mm 2.926 x 2.554 mm 1.278 x 1.256 mm 0.946 x 1.17 mm
Thickness	max. 700 µm max. 430 µm max. 430 µm max. 430 µm
Contact surface	SnAgCu SnAgCu SnAgCu SnAgCu
ISO reference	- - - -
Derivatives	- - - -
Delivery form	Tape & Reel Tape & Reel Tape & Reel Tape & Reel
Main applications	Near-field communication, embedded secure element, authentication - - -

Wafer delivery forms

Wafer delivery forms			
Product name	Bumping NiAu	Stud Bump	Wafer Thinning and Dicing
Picture			
Product description	NiAu bump on the pad	Gold bump on the pad	Bare die delivery on UV foil in wafer frame
Thickness	-	-	55 μm, 150 μm other thicknesses on request
Mapping	Based on SEMI	Based on SEMI	Based on SEMI
Delivery form	Sawn wafer on UV foil	Sawn wafer on UV foil	Sawn wafer on UV foil
Documents	Specification NiAu bumping, chip delivery specification for 8" wafer, general and product-specific issues	Specification stud bumping, chip delivery specification for 8"/12" wafer, general and product-specific issues	Chip delivery specification for 8"/12" wafer, general and product-specific issues

Notes

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- › India 000 800 4402 951 (English)
- › USA 1-866 951 9519 (English/German)
- › Other countries 00* 800 951 951 951 (English/German)
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